

SUPERSERVER® SSG-121E-NE3X12R



USER'S MANUAL

Revision 1.0

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Preface

About this Manual

This manual is written for professional system integrators and PC technicians. It provides information for the installation and use of the server. Installation and maintenance should be performed by certified service technicians only.

Please refer to the SSG-121E-NE3X12R server specifications page on our website for updates on supported memory, processors and operating systems (http:// www. supermicro. com).

Notes

For your system to work properly, please follow the links below to download all necessary drivers/utilities and the user's manual for your server.

- Supermicro product manuals: http://www.supermicro.com/support/manuals/
- Product drivers and utilities: https://www.supermicro.com/wdl
- Product safety info: http://www.supermicro.com/about/policies/safety_information.cfm

If you have any questions, please contact our support team at: support@supermicro.com

This manual may be periodically updated without notice. Please check the Supermicro website for possible updates to the manual revision level.

Secure Data Deletion

A secure data deletion tool designed to fully erase all data from storage devices can be found on our website: https://www.supermicro.com/about/policies/disclaimer.cfm?url=/wdl/utility/Lot9_Secure_Data_Deletion_Utility/

Warnings

Special attention should be given to the following symbols used in this manual.



Warning! Indicates important information given to prevent equipment/property damage or personal injury.



Warning! Indicates high voltage may be encountered when performing a procedure.

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Chapter 1

Introduction

1.1 Overview

This chapter provides an outline of the functions and features of the SuperStorage server SSG-121E-NE3X12R. The following provides an overview of the specifications and capabilities.

System Overview		
Motherboard	X13DSF-A	
Chassis	CSE-126E32-R1K62P	
Processors	Dual 4th or 5th Generation Intel Xeon Scalable processors with 4 UPI (16 GT/s max) and a total of 160 Gen5 PCle lanes in a Socket E (LGA-4677), supports 145 W-270 W TDP	
Memory	32 DIMM slots, 1 DPC ECC DDR5 RDIMM/LRDIMM for up to 5600 MT/s (5th Gen)	
Storage	Eight hot-swap E3.S (T1; 7.5 mm) NVMe drive bays Four E3.S (T2; 15 mm)) CXL drive bays Two PCle 3.0 (NVMe or SATA3 Hybrid slots) with support of M-Key 2280 and 22110	
Expansion Slots	Two Gen-Z PCIe 5.0 x16 slots (FHHL) Two Gen-Z x16 AIOM PCIe 5.0 connectors (OCP 3.0 SFF compliant)	
I/O Ports	Four USB 3.0 ports (two front, two rear) One rear RJ45 dedicated 1 GbE IPMI One rear VGA port One rear UID port	
System Cooling	Eight heavy duty 4 cm fans with optimal fan speed control One air shroud	
Power	Two redundant 2000 W power supplies, 80 Plus Titanium level	
Form Factor	1U; (WxHxD) 17.2" x 1.7" x 30.4" in. (438 x 44 x 773 mm)	

A Quick Reference Guide can be found on the product page of the Supermicro website.

The following safety models associated with the SSG-121E-NE3X12R have been certified as compliant with: 126E32-R16X13

1.2 System Features

The following views of the system display the main features.

Front View



Figure 1-1. Front View

System Features: Front	
Feature	Description
Pull-out Tag	Pull-out service or asset tag has the <u>BMC password</u> details
Control Panel Front control panel with LEDs and buttons (see Control Panel for details)	
USB Ports	Two USB 3.0 ports

Logical Storage Drive Numbers		
Item	Description	
0, 1, 6, 7	, 1, 6, 7 Four E3.S (T2) CXL drive bays	
2-5, 8-11 Eight hot-swap E3.S (T1) NVMe drive bays		

Drive Carrier Indicators

Each drive carrier has two LED indicators: an activity indicator and a status indicator. For RAID configurations using a controller, the meaning of the status indicator is described in the table below. For OS RAID or non-RAID configurations, some LED indications are not supported, such as hot spare. For VROC configurations, refer to the <u>VROC section</u> in this manual.

Drive Carrier LED Indicators			
	Color	Blinking Pattern	Behavior for Device
	Blue	Solid On	Idle SAS/NVMe drive installed
Activity LED	Blue	Blinking	I/O activity
	Off		Idle SATA drive installed
	Red	Solid On	Failure of drive with RSTe support
	Red	Blinking at 1 Hz	Rebuild drive with RSTe support
	Red	Blinking with two blinks and one stop at 1 Hz	Hot spare for drive with RSTe support
Status LED	Red	On for five seconds, then off	Power on for drive with RSTe support
	Red	Blinking at 4 Hz	Identify drive with RSTe support
	Green	Solid on	Safe to remove NVMe drive
	Amber	Blinking at 1 Hz	Do not remove NVMe drive

Control Panel

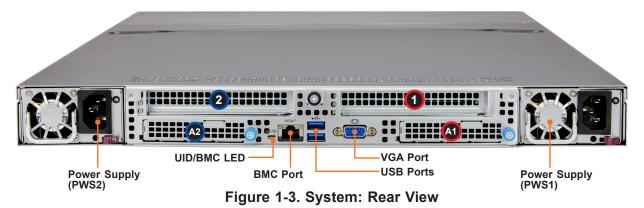


Figure 1-2. Control Panel

Control Panel Features		
Feature	Description	
Power button	The main power switch applies or removes primary power from the power supply to the server but maintains standby power.	
Reset/UID Button	This button can also be used to reset the BMC. The reset button is used to reboot the system	
Power LED	Indicates power is being supplied to the system power supply units. This LED is illuminated when the system is operating normally.	
Drive LED	Indicates activity on the storage drives when flashing.	
NIC 1 LED	Indicates network activity on LANs when flashing.	
NIC 2 LED	Indicates network activity on LANs when flashing.	
Information LED	Alerts operator to several states, as noted in the table below.	

Information LED		
Color, Status	Description	
Red, continuously	An overheat condition has occurred.	
Red, blinking at 1 Hz	Fan failure, check for an inoperative fan.	
Red, blinking at 0.25 Hz	Power failure, check for a non-operational power supply.	
Blue, solid	UID has been activated locally to locate the server in a rack environment.	
Blue, blinking	UID has been activated using the BMC to locate the server in a rack environment.	

Rear View



System Features: Rear		
Feature	Description	
Power Supplies	Two redundant power supply modules (PWS1 on the right, PWS2 on the left)	
UID/BMC LED	Status indicator for UID and BMC reset	
BMC Port	Dedicated LAN port for BMC; for indicator details, see BMC LAN LEDs	
USB Ports	Two USB 3.0 ports	
VGA Port	One video port	

Expansion Slot Locations		
Item	Description	
12	PCIe 5.0 x16 slot (full-height, half length)	
A1 A2	PCIe 5.0 x16 slot (AIOM)	
	CPU1 ■ CPU2 ■	

Power Supply Indicator

Power Supply Indicator				
LED Color and State	Power Supply Condition			
Off	No AC power to modules			
Amber, solid	AC cord unplugged and in redundant mode OR power supply critical events causing a shutdown, failure, OCP, OVP, fan fail, OTP, UVP			
Amber, blinking	Power supply warning events where the power supply continues to operate: high temperature, over voltage, under voltage, etc			
Green, blinking	AC present, only 12 vsb on (module off)			
Green, solid	Output on, functioning normally			

1.3 System Architecture

This section shows the locations of the system's main components.

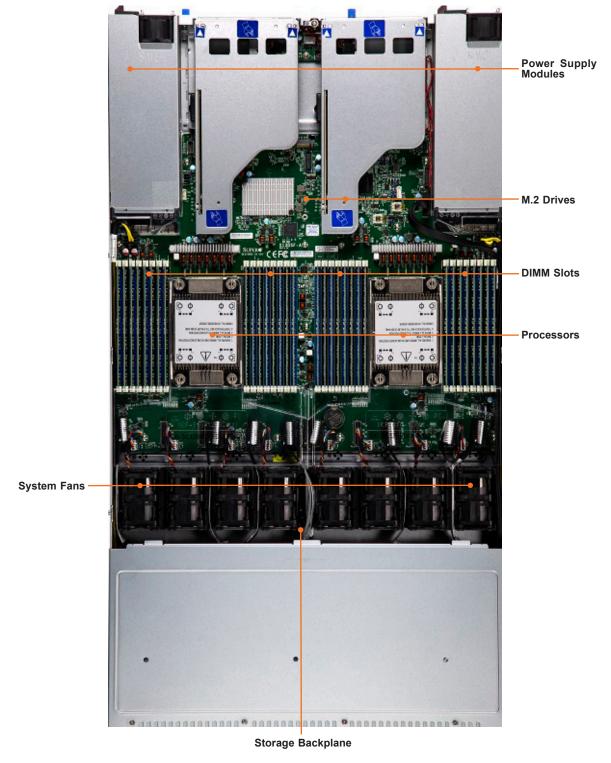


Figure 1-4. Main Component Locations

System Features: Top			
Feature	Description		
Power Supply	Dual redundant modules		
M.2 Drives	Two M.2 drive slots		
DIMM Slots	32 memory slots		
Processors	Dual CPUs and heatsinks		
Storage Backplane	Supporting storage drives		

1.4 Motherboard Layout

Below is a layout of the X13DSF-A motherboard with the jumper, connector and LED locations shown. See the table on the following page for descriptions. For detailed descriptions, pinout information and jumper settings, refer to Chapter 4 or the Motherboard Manual.

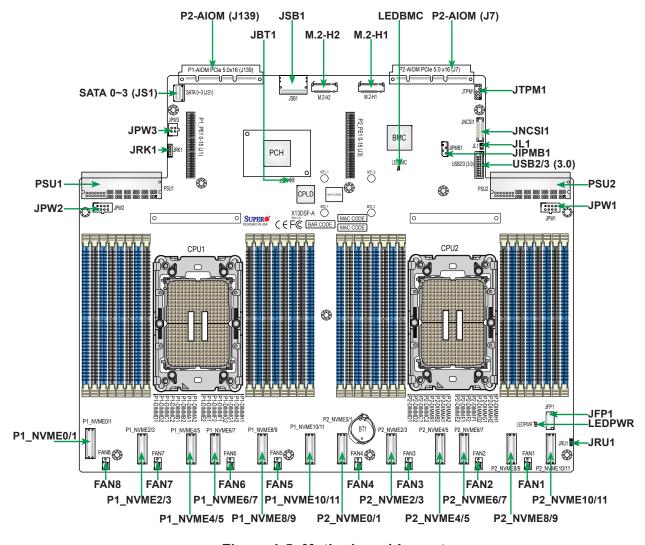


Figure 1-5. Motherboard Layout

Quick Reference Table

Jumper	Description		Default Setting			
JBT1	CMOS Clear		Open (Normal)			
JRU1	UID LED/BMC Reset/System Reset		Pins 1-2: UID LED/BMC Reset (Default) Pins 2-3: System Reset			
LED	Description	Status				
LEDBMC	BMC Heartbeat LED	Blinking Green: BMC Normal (Active), Solid Green: During BMC Reset or during a Cold Reboot				
LEDPWR	Power LED	LED On: C	LED On: Onboard Power On			
Connector	Description					
BT1	Onboard CMOS Battery					
FAN1 – FAN8	4-pin Cooling Fan Headers					
JFP1	Front Control Panel Header with I ² C					
JIPMB1	4-pin BMC External I2C Header					
JL1	Chassis Intrusion Header					
JNCSI1	Network Controller Sideband Interface (NC-SI) Connector for BMC shared LAN					
JPW1, JPW2	8-pin Power Connectors					
JPW3	4-pin Power Connector	4-pin Power Connector				
JRK1	Intel VROC Key Header					
JSB1	Rear I/O Module Connector					
JTPM1	Trusted Platform Module/Port 80 Connector					
M.2-H1, M.2-H2	NVMe PCle 3.0 x4 / SATA 3.0 Hybrid M.2 Slots (Support M-Key 2280 and 22110)					
MT1_1, MT2_1; MT1_2, MT2_2	MT1_1, MT2_1: M.2-H1 Mounting Holes; MT1_2, MT2_2: M.2-H2 Mounting Holes					
P1-AIOM (J139), P2-AIOM (J7)	Supermicro Advanced Input/Output Module (AIOM) PCIe 5.0 x16 Connectors for rear I/O support (OCP 3.0 SFF compliant)					
P1_NVME0/1 - P1_NVME10/11	Six PCIe 5.0 x8 MCIO Connectors supported by CPU1					
P2_NVME0/1 - P2_NVME10/11	Six PCIe 5.0 x8 MCIO Connectors supported by CPU2					
P1_PE1 0-15 (J1)	GenZ x16 Slot (PCIe 5.0) supported by CPU1					
P2_PE1 0-15 (J3)	GenZ x16 Slot (PCIe 5.0) supported by CPU2					
PSU1, PSU2	Power Supply Unit Connectors for system power use					
SATA 0~3 (JS1)	SlimSAS LP Connector with support of four Intel PCH SATA 3.0 connections (Supports RAID 0, RAID 1, RAID 5, and RAID 10)					
USB2/3 (3.0)	USB 3.0 Header for front panel USB 3.0 ports					

Note: The RAID support on this motherboard is limited since Intel VROC and RSTe are being discontinued.

Motherboard Block Diagram

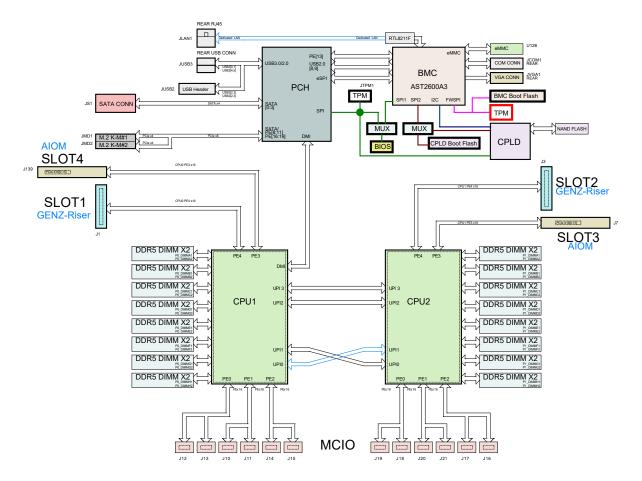


Figure 1-6. Motherboard Block Diagram

Chapter 2

Server Installation

2.1 Overview

This chapter provides advice and instructions for mounting your system in a server rack. If your system is not already fully integrated with processors, system memory etc., refer to Chapter 3 for details on installing those specific components.

Caution: Electrostatic Discharge (ESD) can damage electronic components. To prevent such damage to PCBs (printed circuit boards), it is important to use a grounded wrist strap, handle all PCBs by their edges and keep them in anti-static bags when not in use.

2.2 Unpacking the System

Inspect the box in which the system was shipped, and note if it was damaged. If any equipment appears damaged, file a claim with the carrier.

Decide on a suitable location for the rack unit that will hold the server. It should be situated in a clean, dust-free area that is well ventilated. Avoid areas where heat, electrical noise and electromagnetic fields are generated. It will also require a grounded AC power outlet nearby. Be sure to read the precautions and considerations noted in Appendix A.

2.3 Preparing for Setup

The box in which the system was shipped should include the rackmount hardware needed to install it into the rack. Please read this section in its entirety before you begin the installation.

Choosing a Setup Location

- The system should be situated in a clean, dust-free area that is well ventilated. Avoid areas where heat, electrical noise and electromagnetic fields are generated.
- Leave enough clearance in front of the rack so that you can open the front door completely (~25 inches) and approximately 30 inches of clearance in the back of the rack to allow sufficient space for airflow and access when servicing.
- This product should be installed only in a Restricted Access Location (dedicated equipment rooms, service closets, etc.).

• This product is not suitable for use with visual display workplace devices according to §2 of the German Ordinance for Work with Visual Display Units.

Rack Precautions

- Ensure that the leveling jacks on the bottom of the rack are extended to the floor so that the full weight of the rack rests on them.
- In single rack installations, stabilizers should be attached to the rack. In multiple rack installations, the racks should be coupled together.
- Always make sure the rack is stable before extending a server or other component from the rack.
- You should extend only one server or component at a time extending two or more simultaneously may cause the rack to become unstable.

Server Precautions

- Review the electrical and general safety precautions in Appendix A.
- Determine the placement of each component in the rack *before* you install the rails.
- Install the heaviest server components at the bottom of the rack first and then work your way up.
- Use a regulating uninterruptible power supply (UPS) to protect the server from power surges and voltage spikes and to keep your system operating in case of a power failure.
- Allow any drives and power supply modules to cool before touching them.
- When not servicing, always keep the front door of the rack and all covers/panels on the servers closed to maintain proper cooling.

Rack Mounting Considerations

Ambient Operating Temperature

If installed in a closed or multi-unit rack assembly, the ambient operating temperature of the rack environment may be greater than the room's ambient temperature. Therefore, consideration should be given to installing the equipment in an environment compatible with the manufacturer's maximum rated ambient temperature (TMRA).

Airflow

Equipment should be mounted into a rack so that the amount of airflow required for safe operation is not compromised.

Mechanical Loading

Equipment should be mounted into a rack so that a hazardous condition does not arise due to uneven mechanical loading.

Circuit Overloading

Consideration should be given to the connection of the equipment to the power supply circuitry and the effect that any possible overloading of circuits might have on overcurrent protection and power supply wiring. Appropriate consideration of equipment nameplate ratings should be used when addressing this concern.

Reliable Ground

A reliable ground must be maintained at all times. To ensure this, the rack itself should be grounded. Particular attention should be given to power supply connections other than the direct connections to the branch circuit (i.e. the use of power strips, etc.).



To prevent bodily injury when mounting or servicing this unit in a rack, you must take special precautions to ensure that the system remains stable. The following guidelines are provided to ensure your safety:

- This unit should be mounted at the bottom of the rack if it is the only unit in the rack.
- When mounting this unit in a partially filled rack, load the rack from the bottom to the top with the heaviest component at the bottom of the rack.
- If the rack is provided with stabilizing devices, install the stabilizers before mounting or servicing the unit in the rack.
- Slide rail mounted equipment is not to be used as a shelf or a work space.

2.4 Installing the Rails

There are a variety of rack units on the market, which may require a slightly different assembly procedure. This rail set fits a rack between 26.8" and 36.4" deep.

The following is a basic guideline for installing the system into a rack with the rack mounting hardware provided. You should also refer to the installation instructions that came with the specific rack you are using.

Identifying the Rails

The chassis package includes two rail assemblies. Each assembly consists of three sections: An inner rail that secures directly to the chassis, an outer rail that secures to the rack, and a middle rail which extends from the outer rail. These assemblies are specifically designed for the left and right side of the chassis and labeled.

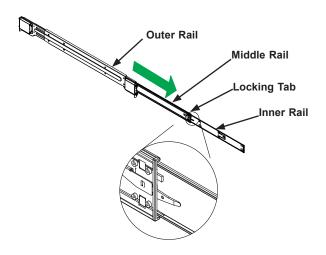


Figure 2-1. Identifying the Outer Rail, Middle Rail and Inner Rail (Left Rail Assembly Shown)

Releasing the Inner Rail

Each inner rail has a locking latch. This latch prevents the server from coming completely out of the rack when when the chassis is pulled out for servicing.

To mount the rail onto the chassis, first release the inner rail from the outer rails.

- 1. Pull the inner rail out of the outer rail until it is fully extended as illustrated below.
- 2. Press the locking tab down to release the inner rail.
- 3. Pull the inner rail all the way out.

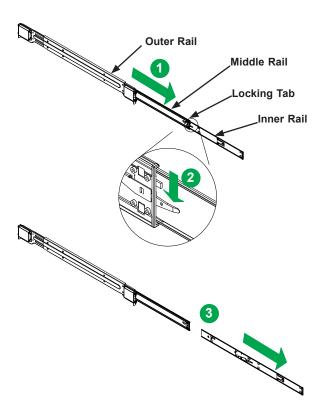


Figure 2-2. Extending and Releasing the Inner Rail

Installing the Inner Rails on the Server

Installing the Inner Rails

- 1. Identify the left and right inner rails. They are labeled.
- 2. Place the inner rail firmly against the side of the chassis, aligning the hooks on the side of the chassis with the holes in the inner rail.
- 3. Slide the inner rail forward toward the front of the chassis until the quick release bracket snaps into place, securing the rail to the chassis.
- 4. Optionally, you can further secure the inner rail to the chassis with screws.

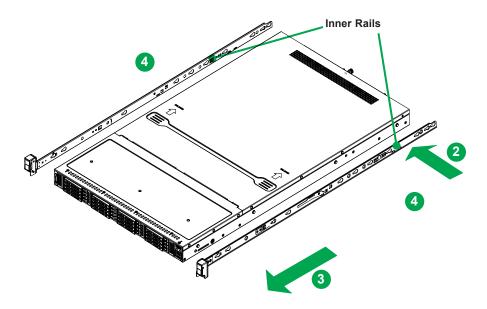


Figure 2-3. Installing the Inner Rails

Installing the Outer Rails onto the Rack

Each end of the assembled outer rail includes a bracket with hooks and square, spring-loaded pegs to fit into the square holes in your rack.

Installing the Outer Rail

- 1. Press upward on the locking tab at the rear end of the middle rail.
- 2. Push the middle rail back into the outer rail.
- 3. Hang the hooks on the front of the outer rail onto the square holes on the front of the rack. If desired, use screws to secure the outer rails to the rack.
- 4. Pull out the rear of the outer rail, adjusting the length until it just fits within the posts of the rack.
- 5. Hang the hooks of the rear section of the outer rail onto the square holes on the rear of the rack. Take care that the proper holes are used so the rails are level. If desired, use screws to secure the rear of the outer rail to the rear of the rack.

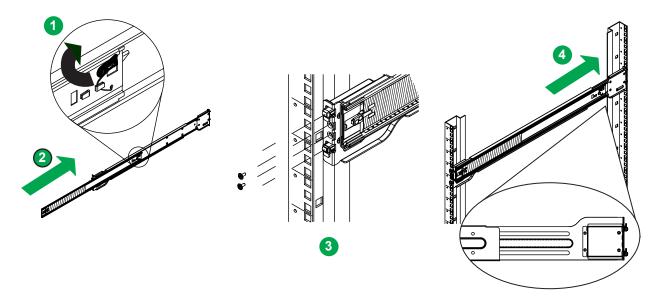


Figure 2-4. Extending and Mounting the Outer Rails

Note: The figure above is for illustrative purposes only. Always install servers at the bottom of the rack first.



Stability hazard. The rack stabilizing mechanism must be in place, or the rack must be bolted to the floor before you slide the unit out for servicing. Failure to stabilize the rack can cause the rack to tip over.



Warning: Do not pick up the server with the front handles. They are designed to pull the system from a rack only.

2.5 Installing the Server into a Rack

Once rails are attached to the chassis and the rack, you can install the server.



Warning: Mounting the system into the rack requires at least two people to support the chassis during installation. Please follow safety recommendations printed on the rails.

Installing the Chassis into a Rack

- 1. Extend the outer rails as illustrated.
- 2. Align the inner rails of the chassis with the outer rails on the rack.
- 3. Slide the inner rails into the outer rails, keeping the pressure even on both sides. When the chassis has been pushed completely into the rack, it should click into the locked position.
- 4. Optional screws may be used to hold the front of the chassis to the rack.

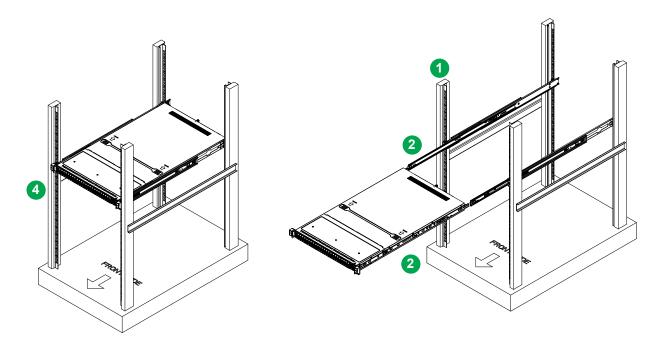


Figure 2-5. Installing the Server into the Rack

Note: Keep the ball bearing shuttle locked at the front of the middle rail during installation.

Note: Figure is for illustrative purposes only. Always install servers to the bottom of a rack first.

Removing the Server from the Rack

Caution! It is dangerous for a single person to off-load the heavy chassis from the rack without assistance. Be sure to have sufficient assistance supporting the chassis when removing it from the rack. Use a lift.

- 1. If necessary, loosen the thumb screws on the front of the chassis that hold it in the rack.
- 2. Pull the chassis forward out the front of the rack until it stops.
- 3. Press the release latches on each of the inner rails downward simultaneously and continue to pull the chassis forward and out of the rack.

Chapter 3

Maintenance and Component Installation

This chapter provides instructions on installing and replacing main system components. To prevent compatibility issues, only use components that match the specifications and/or part numbers given.

Installation or replacement of most components require that power first be removed from the system. Please follow the procedures given in each section.

3.1 Removing Power

Use the following procedure to ensure that power has been removed from the system. This step is necessary when removing or installing non hot-swap components or when replacing a non-redundant power supply.

- 1. Use the operating system to power down the system.
- 2. After the system has completely shut-down, disconnect the AC power cord(s) from the power strip or outlet. (If your system has more than one power supply, remove the AC power cords from all power supply modules.)
- 3. Disconnect the power cord(s) from the power supply module(s).

Note: This caution statement applies when changing any component or subsystem that is not hot-swap/hot-plug.

3.2 Accessing the System

The chassis features a removable top cover for access to the internal components.

Removing the Chassis Cover

- 1. Remove power from the system as described in <u>Section 3.1</u>.
- 2. Remove the screws securing the cover to the chassis.
- 3. Lift the cover off the chassis.

Check that all ventilation openings on the top cover and the top of the chassis are clear and unobstructed.

Caution: Except for short periods of time, do not operate the server without the cover in place. The chassis cover must be in place to allow for proper airflow and to prevent overheating.

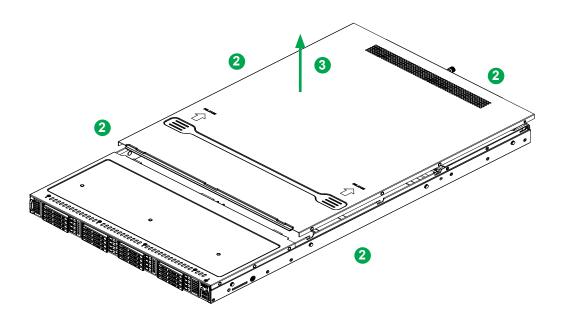
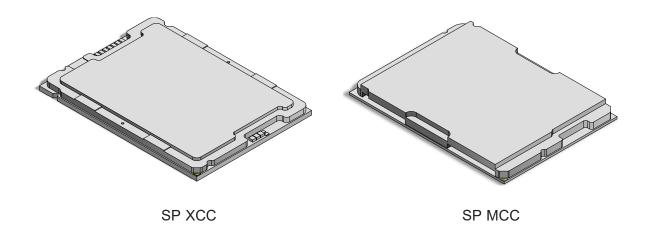


Figure 3-1. Removing the Chassis Cover

3.3 Processor and Heatsink

Processor Overview

The motherboard supports two versions of the 5th Generation Intel Xeon Scalable processors processors. They differ in the number of cores, and each requires a different CPU carrier. The XCC version supports up to 60 cores, and the MCC version supports up to 32 cores. The CPU carriers differ by the presence or absence of shims and levers.



CPU and Carrier Type								
CPU Type	Cores	Carrier Type	Lever	Shim	Carrier Part Number			
хсс	60	E1A	Yes	No	SKT-1333L-0000-FXC (alt: SKT-1333L-0001-LTS)			
мсс	32	E1B	Yes	Yes	SKT-1424L-001B-FXC (alt: SKT-1424L-001B-LTS)			

Installation Overview

The processor (CPU) and processor carrier should be assembled together first to form the processor carrier assembly. This will be attached to the heatsink to form the processor heatsink module (PHM) before being installed onto the CPU socket.

Notes:

- · Use ESD protection.
- The sytem power cords must be removed from all power supplies.
- Check that the plastic protective cover is on the CPU socket and none of the socket pins are bent. If they are, contact your retailer.
- When handling the processor, avoid touching or placing direct pressure on the LGA lands (gold contacts). Improper installation or socket misalignment can cause serious damage to the processor or socket, which may require manufacturer repairs.
- When installing the processor and heatsink, ensure a torque driver set to the correct force is used for each screw.
- Refer to the Supermicro website for updates on processor support.

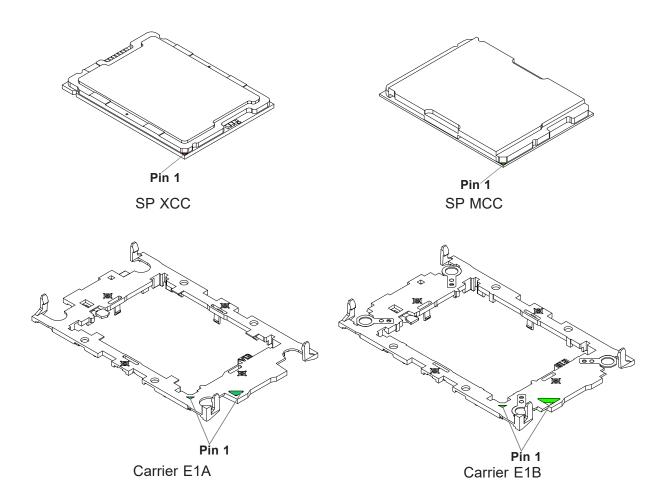
Installation Procedure Overview

After preparing the system, and following ESD precautions, there are four steps to installing the processor and heatsink onto the motherboard.

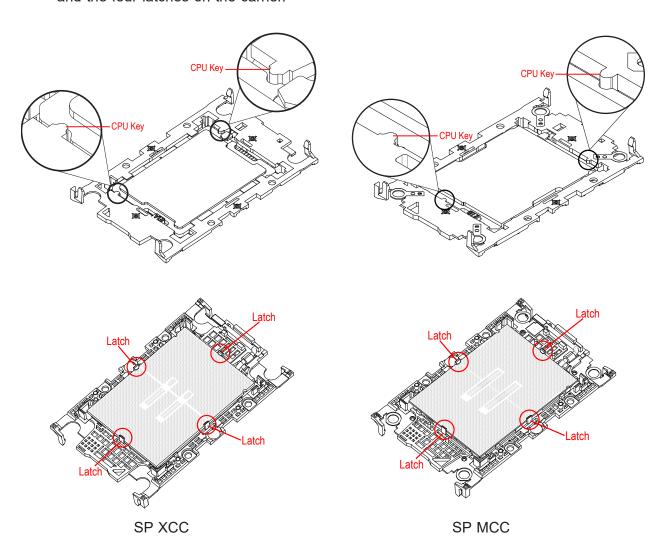
- 1. Attach the processor to a plastic carrier to create the processor carrier assembly.
- 2. Attach the processor carrier assembly to the heatsink to create the processor heatsink module (PHM).
- 3. Remove the socket cover.
- 4. Install the PHM.

Assembling the Processor and Carrier

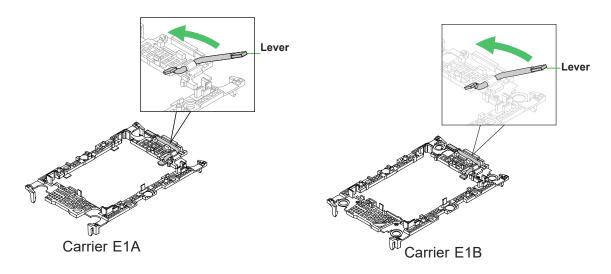
1. Hold the processor with the gold pins (LGA lands) facing down. Locate the gold triangle at the corner of the processor and the corresponding hollowed triangle on the processor carrier as shown below. These triangles indicate the location of pin 1.



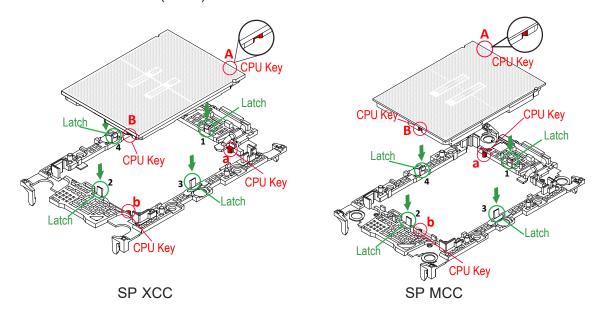
2. Turn the processor over (with the gold pins up). Locate the CPU keys on the processor and the four latches on the carrier.



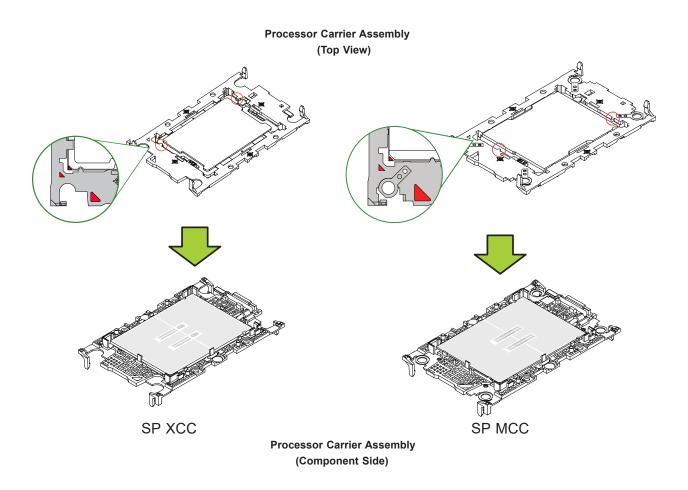
3. Locate the lever on the processor carrier and press it down.



4. Using pin 1 as a guide, carefully align the CPU keys on the processor (A & B) with those on the carrier (a & b).



5. Once aligned, carefully insert the CPU into the carrier, making sure that the CPU is secured by latches 1, 2, 3, and 4..

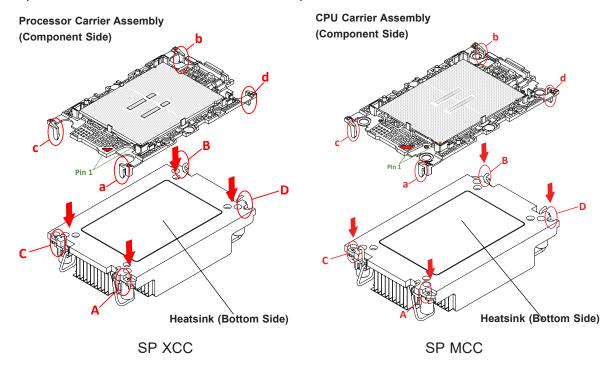


Assembling the Processor Heatsink Module

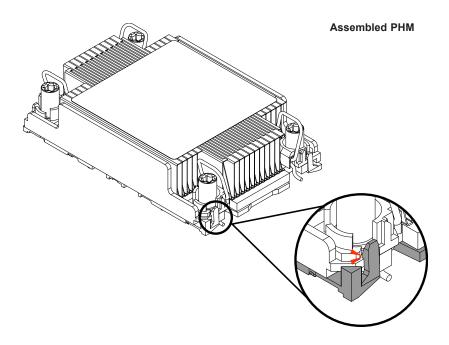
Thermal grease is pre-applied on a new heatsink. No additional thermal grease is needed. If this is a re-installation, apply the proper amount of thermal grease to the underside of the heatsink.

Assembling the Processor Heatsink Module (PHM)

- 1. Turn the heatsink over with the thermal grease facing up. Pay attention to the two triangle cutouts (A, B) located at the diagonal corners of the heatsink as shown in the drawing below.
- 2. Hold the processor carrier assembly upside-down to locate the triangles on the processor and the carrier, which indicate pin 1.



- Turn the processor carrier assembly over so that the gold pins are facing up. Locate the two pin 1 locations ("A" on the processor and "a" on the processor carrier assembly).
- 4. Align "a" on the processor carrier assembly with the triangular cutout "A" on the heatsink along with "b", "c", "d" on the processor assembly with "B", "C", "D" on the heatsink.
- 5. Once properly aligned, place the heatsink on the processor carrier assembly with all corners matched up, making sure that the four clips are properly securing the heatsink.



Note: The figure is for illustrative purposes. Your components may differ slightly from the components shown.

Removing the Socket Cover

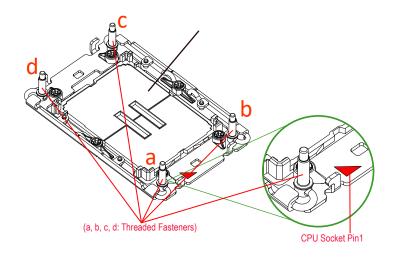
Remove the plastic protective cover from the socket by gently squeezing the grip tabs and pulling the cover off.

CPU Socket with Plastic Protective Cover

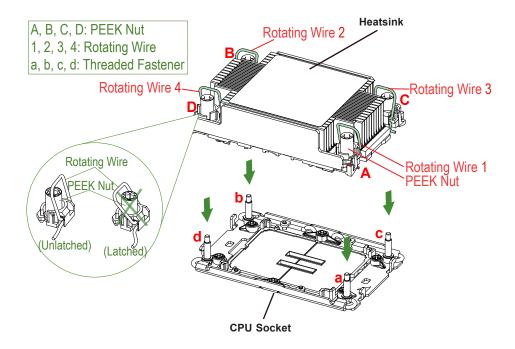
Installing the PHM

To install the PHM into the CPU socket, follow these steps.

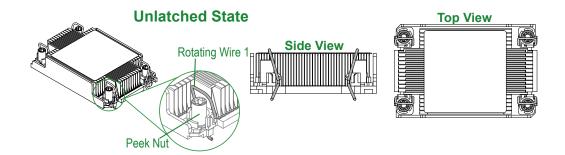
1. Locate four threaded fasteners (a, b, c, d) and Pin 1 on the CPU socket.



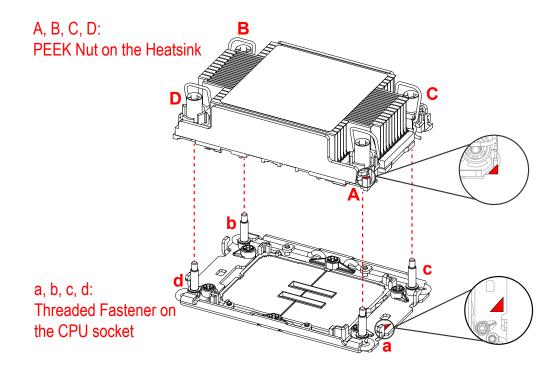
2. Locate four PEEK nuts (A, B, C, D) and four rotating wires (1, 2, 3, 4) on the heatsink.



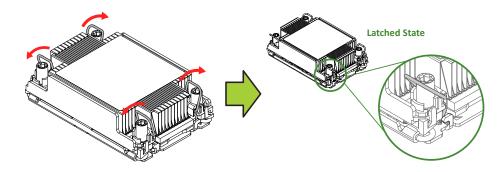
3. Check the rotating wires (1, 2, 3, 4) to make sure that they are in the unlatched position.



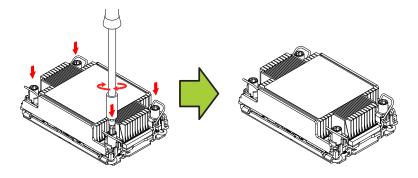
- 4. Align PEEK nut "A" (next to the trianglular pin 1 on the heatsink) with threaded fastener "a" on the CPU socket. Then align PEEK nuts "B", "C", "D" on the heatsink with threaded fasteners "b", "c", "d" on the CPU socket.
- 5. Once aligned, gently place the PHM on the CPU socket, making sure that each PEEK nut is properly attached to its corresponding threaded fastener.



6. Press all four rotating wires outward and make sure that the heatsink is securely latched into the CPU socket.



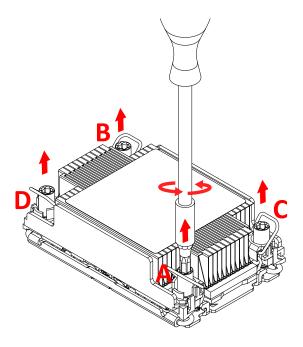
- 7. With a T30-bit torque driver, tighten all PEEK nuts in the sequence of "A", "B", "C", and "D" with even pressure. Note the torque specifications, 8.0 IN-LBF (0.904 N-M) when tightening the screws.
- 8. Examine all corners of the heatsink to ensure that the PHM is firmly attached to the CPU socket.



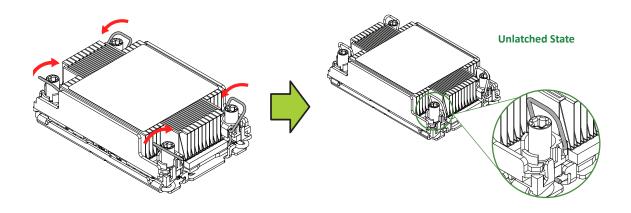
Removing the PHM

To remove the processor heatsink module (PHM) from the motherboard, follow these steps.

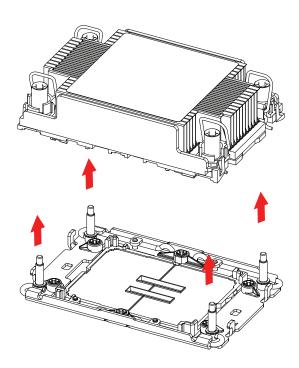
- 1. Shut down the system and unplug the AC power cord from all power supplies.
- 2. Use a T30-bit screwdriver to loosen the four PEEK nuts on the heatsink in the sequence of A, B, C, and D.



3. Press the rotating wires inward to unlatch the PHM from the socket as shown below.



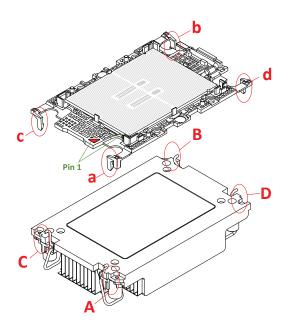
4. Gently lift the PHM upward to remove it from the CPU socket.



Removing the Carrier Assembly from the Heatsink

To remove the processor carrier assembly from the PHM, follow these steps:

1. Detach the four plastic clips (marked a, b, c, d) on the processor carrier assembly from the four corners of the heatsink (marked A, B, C, D) as shown below.

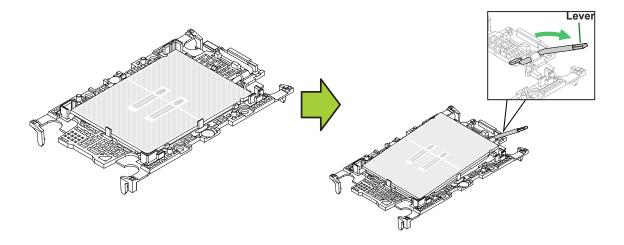


2. When all plastic clips have been detached from the heatsink, remove the processor carrier assembly from the heatsink

Removing the Processor from the Carrier Assembly

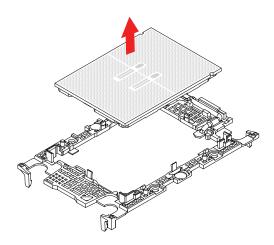
To remove the processor from the processor carrier, follow these steps.

1. Unlock the lever from its locked position and push it upwards to disengage the processor from the processor carrier as shown below right.



2. Once the processor has been loosened from the carrier, carefully remove the processor from the carrier.

Note: Handle the processor with care.



3.4 Memory

Memory Support

This motherboard supports up to 8 TB 3DS RDIMM/RDIMM DDR5 (288-pin) ECC memory. Memory speed and capacity support depends on the processors used in the system. The 4th Gen Scalable processors support memory with speeds up to 4800MT/s in 16 slots (or up to 4400 MT/s in 32 DIMM configuration). The 5th Gen Scalable processors support memory with speeds up to 5600MT/s in 16 slots (or up to 4400 MT/s in 32 DIMM configuration). LRDIMM/LRDIMM-3DS is not supported. For validated memory, use our <u>Product Resources page</u>.

DDR5 Memory Support for the 4th Gen Scalable Processors-SP					
Туре					
	Ranks Per DIMM and Data			One DIMM per Channel 1	Two DIMMs per Channel
	Width (Stack)	Memory Density 16 Gb	Memory Density 24 Gb ²	1.1 Volts	
	SRx8 (RC D)	16 GB	24 GB	4800*	4400*
	SRx4 (RC C)	32 GB	48 GB		
RDIMM	SRx4 (RC F) 9x4	32 GB	NA		
KDIIVIIVI	DRx8 (RC E)	32 GB	48 GB		
	DRx4 (RC A)	64 GB	96 GB		
	DRx4 (RC B) 9x4	64 GB	NA		
RDIMM 3DS	(4R/8R) x4 (RC A)	2H-128 GB 4H-256 GB	NA		

^{*}Memory speed and capacity support depends on the processors used in the system.

Note 1: 1DPC applies to 1SPC or 2SPC implementations (SPC - sockets per channel).

Note 2: 24 Gb XCC only with limited configs: 1DPC all DIMM types, 2DPC 96 GB only. Only 8 and 16 DIMM configs, no failbacks.

Note 3: Memory speed will be 4800 MT/s 1DPC or 4400 MT/s 2DPC.

Note 4: Mixing DRAM density (16 Gb/24 Gb) and/or frequency is not allowed.

DDR5 Memory Support for the 5th Generation Intel Xeon Scalable processors Processors					
Туре				Speed (MT/s)	
	Ranks Per DIMM and Data	DIMM Capac	ity (GB)	One DIMM per Channel 1	Two DIMMs per Channel
	Width (Stack)	Memory Density 16 Gb	Memory Density 24 Gb ²	1.1 Volts	
	SRx8 (RC D)	16GB	24GB		
	SRx4 (RC C)	32GB	48GB	5600*	4800*
RDIMM	SRx4 (RC F) 9x4	32GB	NA		
RDIMIM	DRx8 (RC E)	32GB	48GB		
	DRx4 (RC A)	64GB	96GB		
	DRx4 (RC B) 9x4	64GB	NA		
RDIMM 3DS	(4R/8R) x4 (RC A)	2H-128 GB 4H-256 GB	NA		

*Memory speed and capacity support depends on the processors used in the system.

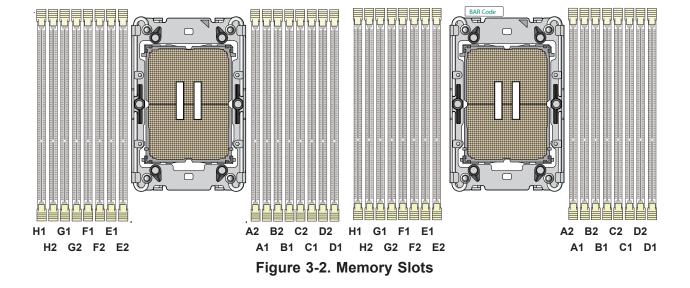
Note 1: 1DPC applies to 1SPC or 2SPC implementations (SPC - sockets per channel).

Note 2: 24 Gb XCC only with limited configs: 1DPC all DIMM types, 2DPC 96 GB only. Only 8 and 16 DIMM configs, no failbacks.

Note 3: Memory speed will be 5600 MT/s 1DPC or 4400 MT/s 2DPC.

Note 4: For 1DPC 5600MT/s speed, DDR5-5600 DIMMs are required

Note 5: Mixing DRAM density (16 Gb/24 Gb) and/or frequency is not allowed.



XCC and MCC CPUs

Use the DIMM slots listed below for memory modules. This memory population table is based on guidelines provided by Intel to support Supermicro motherboards.

Memory	Population for the X13 DP Motherboard, 32 DIMM Slots
CPUs/DIMMs	DIMM Slots
1 CPU & 1 DIMM	A1 or B1 or E1 or F1
1 CPU & 2 DIMMs	A1, G1 or C1, E1
1 CPU & 4 DIMMs	A1, C1, E1, G1
1 CPU & 6 DIMM	A1, C1, D1, E1, F1, G1 or A1, B1, C1, E1, G1, H1 or B1, C1, D1, E1, F1, H1 or A1, B1, D1, F1, G1, H1
1 CPU & 8 DIMMs	A1, B1, C1, D1, E1, F1, G1, H1
1 CPU & 12 DIMMs	A1, A2, B1, C1, C2, D1, E1, E2, F1, G1, G2, H1 or A1, B1, B2, C1, D1, D2, E1, F1, F2, G1, H1, H2
1 CPU & 16 DIMMs	A1, A2, B1, B2, C1, C2, D1, D2, E1, E2, F1, F2, G1, G2, H1, H2
2 CPUs & 2 DIMMs	CPU1 A1, and CPU2: A1 or CPU1 B1, and CPU2: B1 or CPU1 E1, and CPU2: E1 or CPU1 F1, and CPU2: F1
2 CPUs & 4 DIMMs	CPU1 A1, G1 and CPU2: A1, G1 or CPU1 C1, E1 and CPU2: C1, E1
2 CPUs & 8 DIMMs	CPU1: A1, C1, E1, G1, and CPU2: A1, C1, E1, G1
2 CPUs & 10 DIMMs	CPU1: A1, C1, D1, E1, F1, G1, and CPU2: A1, C1, E1, G1
2 CPUs & 12 DIMMs	CPU1: A1, C1, D1, E1, F1, G1 and CPU2: A1, C1, D1, E1, F1, G1 or CPU1: A1, B1, C1, E1, G1, H1 and CPU2: A1, B1, C1, E1, G1, H1 or CPU1: B1, C1, D1, E1, F1, H1 and CPU2: B1, C1, D1, E1, F1, H1 or CPU1: A1, B1, D1, F1, G1, H1 and CPU2: A1, B1, D1, F1, G1, H1
2 CPUs & 16 DIMMs	CPU1: A1, B1, C1. D1, E1, F1, G1, H1, and CPU2: A1, B1, C1. D1, E1, F1, G1, H1
2 CPUs & 22 DIMMs	CPU1: A1, A2, B1, B2, C1. C2, D1, D2, E1, E2, F1, F2, G1, G2, H1, H2 CPU2: A1, C1. D1, E1, F1, G1
2 CPUs & 24 DIMMs	CPU1: A1, A2, B1, B2, C1. C2, D1, D2, E1, E2, F1, F2, G1, G2, H1, H2 CPU2: A1, B1, C1. D1, E1, F1, G1, H1
2 CPUs & 32 DIMMs	CPU1: A1, A2, B1, B2, C1. C2, D1, D2, E1, E2, F1, F2, G1, G2, H1, H2 CPU2: A1, A2, B1, B2, C1. C2, D1, D2, E1, E2, F1, F2, G1, G2, H1, H2

Memory Population Guidelines

- All DIMMs must be DDR5.
- Balanced memory. Using unbalanced memory topology, such as populating two DIMMs in one channel while populating one DIMM in another channel, reduces performance. It is not recommended for Supermicro systems.
- In single-CPU configurations, memory must be installed in the DIMM slots associated with the installed CPU.

Guidelines Regarding Mixing DIMMs

- Populating slots with a pair of DIMM modules of the same type and size results in interleaved memory, which improves memory performance.
- Use memory modules of the same type and speed, as mixing is not allowed.
- x4 and x8 DIMMs can be mixed in the same channel.

DIMM Construction

- RDIMM (non-3DS) Raw Cards: A/B (2Rx4), C (1Rx4), D (1Rx8), E (2Rx8)
- 3DS RDIMM Raw Cards: A/B (4Rx4)
- LRDIMM (non-3DS) Raw Cards: D/E (4Rx4)
- 3DS LRDIMM Raw Cards: A/B (8Rx4)

Installing Memory

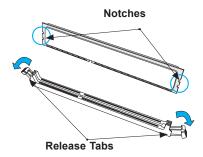
Electrostatic Discharge (ESD) can damage electronic components including memory modules. To avoid damaging DIMM modules, it is important to handle them carefully. The following measures are generally sufficient.

- Use a grounded wrist strap designed to prevent static discharge.
- · Handle the memory module by its edges only.
- Put the memory modules into the antistatic bags when not in use.

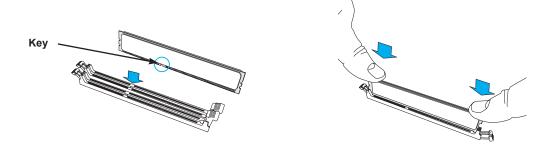
Installing Memory

Begin by removing power from the system as described in Section 3.1. Follow the memory population sequence in the table above.

1. Push the release tabs outwards on both ends of the DIMM slot to unlock it.



2. Align the key of the DIMM with the receptive point on the memory slot and with your thumbs on both ends of the module, press it straight down into the slot until the module snaps into place.



3. Press the release tabs to the locked position to secure the DIMM module into the slot.

Caution: Exercise extreme caution when installing or removing memory modules to prevent damage to the DIMMs or slots.

Removing Memory

To remove a DIMM, unlock the release tabs then pull the DIMM from the memory slot.

3.5 Motherboard Battery

The motherboard uses non-volatile memory to retain system information when system power is removed. This memory is powered by a lithium battery residing on the motherboard.

Replacing the Battery

Begin by <u>removing power</u> from the system.

- 1. Push aside the small clamp that covers the edge of the battery. When the battery is released, lift it out of the holder.
- 2. To insert a new battery, slide one edge under the lip of the holder with the positive (+) side facing up. Then push the other side down until the clamp snaps over it.

Note: Handle used batteries carefully. Do not damage the battery in any way; a damaged battery may release hazardous materials into the environment. Do not discard a used battery in the garbage or a public landfill. Please comply with the regulations set up by your local hazardous waste management agency to dispose of your used battery properly.

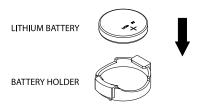


Figure 3-3. Installing the Onboard Battery

Warning: There is a danger of explosion if the onboard battery is installed upside down (which reverses its polarities). This battery must be replaced only with the same or an equivalent type recommended by the manufacturer (CR2032).

3.6 Storage Drives

The system supports four 15 mm (T2) CXL drives and eight hot-swap 7.5 mm (T1) E3.S NVMe storage drives. For compatible storage drives, use the SSG-121E-NE3X12R web page.

The drives are mounted in toolless drive carriers that simplify their removal from the chassis. These carriers also help promote proper airflow.

Note: Enterprise level drives are recommended for use in Supermicro chassis and servers. For information on recommended drives, visit the Supermicro website product pages at www.supermicro.com/products.

Installing Drives



Figure 3-4. Logical Drive Numbers

Logical Storage Drive Numbers		
Item	Description	
0, 1, 6, 7	Four E3.S (T2) CXL drive bays	
2-5, 8-11	-5, 8-11 Eight hot-swap E3.S (T1) NVMe drive bays	

Removing a Hot-Swap Drive Carrier from the Server

- 1. Pull the latch on the drive carrier to extend the drive carrier handle.
- 2. Use the drive carrier handle to pull the drive out of the chassis.

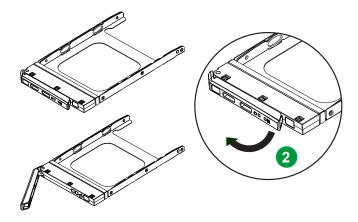
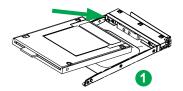


Figure 3-5. Removing an E3.S (1T) Drive Carrier

Installing an SSD Drive

- 1. Align the two front guide holes and pins before sliding the SSD into the tray.
- 2. Rotate the SSD to clip the holes and pins on the left and right sides of the guide.





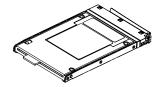


Figure 3-6. Installing the SSD into the Drive Carrier

- 3. Insert the drive carrier with the drive into its bay, keeping the carrier oriented so that the drive is on the top of the carrier and the release button is on the right side. When the carrier reaches the rear of the bay, the release handle will retract.
- 4. Push the handle in until it clicks into its locked position.

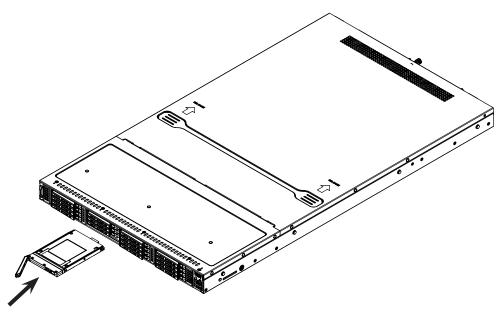


Figure 3-5. Installing an E3.S (1T) Drive Carrier in the Server

Insuring the CXL Drives Are Properly Installed

Use Linux commmands to detect the CXL drives.

```
oot@smc:~# lspci -vvv|grep -i cxl
7:00.0 CXL: Device 1b00:c001 (rev 01) (prog-if 10 [CXL Memory Device (CXL 2.x)])
17:00.0
                 Capabilities: [3c4 v1] Designated Vendor–Specific: Vendor=1e98 ID=0000 Rev=0 Len=56: CXL
CXLCap: Cache— IO+ Mem+ Mem HW Init+ HDMCount 1 Viral+
CXLCtl: Cache— IO+ Mem+ Cache SF Cov 0 Cache SF Gran 0 Cache Clean— Viral—
                  Kernel driver in use:
                                                                        1_pci
                 Kernel modules: c
                                                           1_pci
                 CXL: Device 1b00:c001 (rev 01) (prog-if 10 [CXL Memory Device (CXL 2.x)])
Capabilities: [3c4 v1] Designated Vendor-Specific: Vendor=1e98 ID=0000 Rev=0 Len=56: CXL
CXLCap: Cache— IO+ Mem+ Mem HW Init+ HDMCount 1 Viral+
CXLC11: Cache— IO+ Mem+ Cache SF Cov 0 Cache SF Gran 0 Cache Clean— Viral—
2a:00.0
                                           Sta: Viral-
                  Kernel driver in use: o
                 Kernel modules: cxl_pci

CxL: Device 1b00:c001 (rev 01) (prog-if 10 [CXL Memory Device (CXL 2.x)])

Capabilities: [3c4 v1] Designated Vendor-Specific: Vendor=1e98 ID=0000 Rev=0 Len=56: CXL

CXLCap: Cache— IO+ Mem+ Mem HW Init+ HDMCount 1 Viral+

CXLCtl: Cache— IO+ Mem+ Cache SF Cov 0 Cache SF Gran 0 Cache Clean— Viral—
99:00.0
                                           Sta: Viral-
                 Kernel driver in use:
                                                                        d_pci
                 Kernel modules: 😄
                                                           1_pci
                 CXL: Device 1b00:c001 (rev 01) (prog-if 10 [CXL Memory Device (CXL 2.x)])

Capabilities: [3c4 v1] Designated Vendor-Specific: Vendor=1e98 ID=0000 Rev=0 Len=56: CXL

CXLCap: Cache— IO+ Mem+ Mem HW Init+ HDMCount 1 Viral+

CXLC11: Cache— IO+ Mem+ Cache SF Cov 0 Cache SF Gran 0 Cache Clean— Viral—
ab:00.0
                                           Sta: Viral-
                 Kernel driver in use:
                                                                        1_pci
Kernel modules: cxl
root@smc:~# ls −1 /dev/cxl*
                                                          cl_pci
total O
                        1 root root 511, 0 Jan 31 23:22 mem0
1 root root 511, 1 Jan 31 23:22 mem1
1 root root 511, 2 Jan 31 23:22 mem2
1 root root 511, 3 Jan 31 23:22 mem3
```

Figure 3-6. Detecting the CXL Drives

3.7 System Cooling

Eight 4 cm heavy duty fans provide the cooling for the system. Fan speed is controlled by system temperature using the BMC. If a fan fails, the remaining fans will ramp up to full speed and the system will continue to operate. Replace any failed fan at your earliest convenience with the same type and model.

Make sure the chassis top cover makes a good seal for proper air circulation.

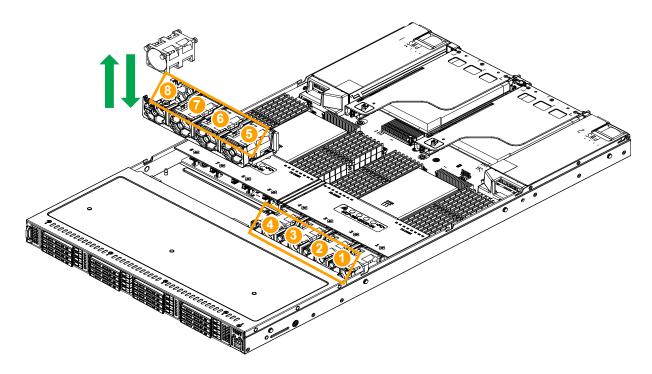


Figure 3-7. Fan Positions

Installing the Air Shrouds

Air shrouds concentrate airflow to maximize fan efficiency. They do not require screws to install.

Installing the Standard Air Shrouds

• Position the air shrouds as illustrated in the figure below, sliding the front over the edge of the fan tray. Align the holes in the edge of the shrouds with the hold in the fan tray.

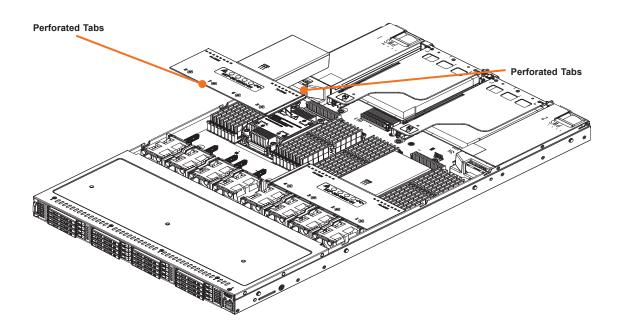


Figure 3-8. Installing the Air Shrouds

3.8 Power Supply

The chassis features redundant power supplies. The system will continue to operate if one module fails. It should be replaced as soon as convenient. The power supply modules are hot-swappable, meaning they can be changed without powering down the system. New units can be ordered directly from Supermicro or authorized distributors.

These power supplies are auto-switching capable. This feature enables them to automatically sense the input voltage and operate at a 100-120 V or 180-240 V.

Power Supply LEDs

On the rear of the power supply module, an LED displays the status.

- **Solid Green**: When illuminated, indicates that the power supply is on.
- Blinking Green: When blinking, indicates that the power supply is plugged in and turned
 off by the system.
- **Blinking Amber:** When blinking, indicates that the power supply has a warning condition and continues to operate.
- **Solid Amber**: When illuminated, indicates that the power supply is plugged in, and is in an abnormal state. The system might need service. Please contact Supermicro technical support.

Changing the Power Supply Module:

- 1. Unplug the AC cord from the module to be replaced.
- 2. On the back of the module, push the release tab sideways.
- 3. Pull the module out using the handle.
- 4. Push the new power supply module into the power bay until it clicks. Replace with the same model.
- 5. Plug the AC power cord back into the module.

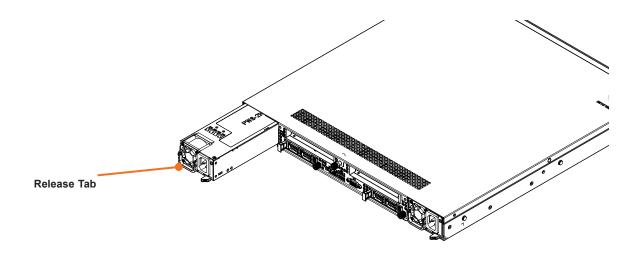


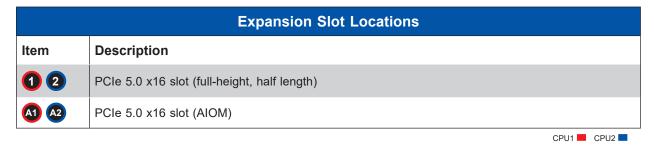
Figure 3-9. Replacing the Power Supply

3.9 PCle Expansion Cards

The system accepts up to four PCIe expansion cards.



Figure 3-10. Expansion Slots



Installing an Expansion Card

- 1. Power down the system as described in <u>section 3.1</u> and remove the cover as described in <u>section 3.2</u>.
- 2. Unscrew and remove the expansion card slot cover.
- 3. Insert the expansion card into a slot on the motherboard while aligning the expansion card backplate with the open slot in the rear of the chassis. Secure with a screw.
- 4. Replace the cover and restore power.

3.10 Cable Routing Diagram

Use this section to route or reroute cables. Proper routing is important to maintain airflow through the system.

Cable part numbers and descriptions are available at the Online Cable Matrix.

MCIO Cables

Backplane Power Cables

Front Panel Cables

USB Cable

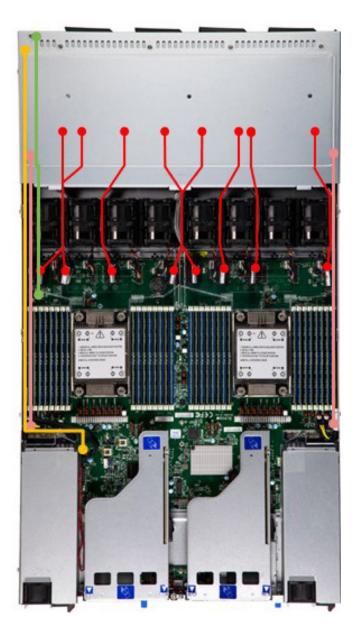


Figure 3-11. Cable Routing Diagram

Chapter 4

Motherboard Connections

This section describes the jumpers, connections and LEDs on the motherboard and provides pinout definitions. Some connections might not be used in this system. A motherboard layout indicating component locations may be found in Chapter 1. More detail can be found in the Motherboard Manual.

4.1 Power Connections

Two power supply connectors, located at PSU1/PSU2, provide main power to your system. The two 8-pin power connectors (JPW1, JPW2) and one 4-pin power connector (JPW3) provide additional power for system use. All these power connectors meet the ATX SSI EPS 12 V specification and must be connected to your power supply to provide adequate power to your system.

Important: To provide adequate power to your system, be sure to connect the main power connectors (PSU1, PSU2) to the power supplies. Failure to do so may void the manufacturer warranty on your power supply and motherboard.

12V 8-pin Power Pin Definitions		
Pin#	Definition	
1 - 4	Ground	
5 - 8	+12 V	

Required Connection

5V/12V 4-pin Power Pin Definitions		
Pin#	Definition	
1	Ground	
2	Ground	
3	+12 V	
4	+5 V	

Required Connection

4.2 Headers and Connectors

Fan Headers

There are eight 4-pin fan headers (FAN1 - FAN8) on the motherboard. Four-pin fan headers are backwards compatible with the traditional 3-pin fans. However, fan speed control is available for 4-pin fans only by Thermal Management uising the BMC 2.0 interface.

Fan Header Pin Definitions		
Pin#	Definition	
1	Ground	
2	2.5 A/+12 V	
3	Tachometer	
4	PWM_Control	

TPM/Port 80 Header

The JTPM1 header is used to connect a Trusted Platform Module (TPM)/Port 80, which is available from Supermicro (optional). A TPM/Port 80 connector is a security device that supports encryption and authentication in drives. It allows the motherboard to deny access if the TPM, which is associated with the drive, is not installed in the system. For more information: https://www.supermicro.com/manuals/other/AOM-TPM-9670V 9670H.pdf.

Trusted Platform Module Header Pin Definitions			
Pin#	Definition	Pin#	Definition
1	+3.3 V	2	SPI_CS#
3	RESET#	4	SPI_MISO
5	SPI_CLK	6	GND
7	SPI_MOSI	8	NC
9	+3.3 V Stdby	10	SPI_IRQ#

4-pin BMC External I²C Header

A System Management Bus header for the BMC is located at JIPMB1. Connect the appropriate cable here to use the IPMB I²C connection on your system.

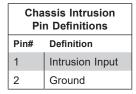
NC-SI Connector

The Network Controller Sideband Interface (NC-SI) connector is located at JNCSI1. This connector is used to connect a Network Interface Card (NIC) to the motherboard to allow the onboard BMC to communicate with a network.

Note: For detailed instructions on how to configure Network Interface Card (NIC) settings, please refer to the Network Interface Card Configuration User's Guide posted on the web page under the link: http://www.supermicro.com/support/manuals/.

Chassis Intrusion

A Chassis Intrusion header is located at JL1 on the motherboard. Attach the appropriate cable from the chassis to inform you when the chassis is opened.



NVMe PCle 3.0 x4 / SATA 3.0 Hybrid M.2 Slots

Two M.2 slots are located at M.2-H1 and M.2-H2 on the motherboard. The hybrid M.2 slots support NVMe PCIe 3.0 x4 and SATA 3.0 M.2 devices in the 2280 and 22110 form factors. M.2 allows for a variety of card sizes, increased functionality, and spatial efficiency.

SATA 3.0 Connector

A SATA 3.0 connector, located at JS1, supports four SATA 3.0 connections (SATA 0~3) on the motherboard. The SATA 3.0 connector is supported by the Intel C741 chipset. Connecting a proper SATA cable to JS1 to use SATA 3.0 connections.

MCIO NVMe Connectors

Twelve MCIO NVMe connectors, located at P1_NVME0/1 - P1_NVME10/11 (supported by CPU1) and P2_NVME0/1 - P2_NVME10/11 (supported by CPU2), provide 24 NVMe PCIe 5.0 x4 connections on the motherboard. Use these MCIO connectors to support high-speed PCIe NVMe storage devices.

Note: When installing an NVMe device on a motherboard, please be sure to connect the NVMe port (P1 NVME0/1) first for your system to work properly.

Universal Serial Bus (USB) Header

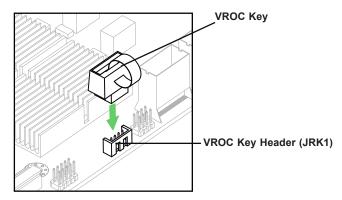
There is one USB 3.0 header, located at USB2/3, supports two USB connections for front access. The USB header can be used for USB support via USB cables (not included).

VROC RAID Key Header

An Intel VROC RAID Key header is located at JRK1 on the motherboard. Install a VROC RAID Key on JRK1 for NVMe RAID support as shown in the illustration below.

Note: For detailed instructions on how to configure VROC RAID settings, please refer to the VROC RAID Configuration User's Guide posted on the web page under the link: https://www.supermicro.com/support/manuals/.

Intel VROC Key Pin Definitions		
Pin# Definition		
1	Ground	
2	3.3 V Standby	
3	Ground	
4	PCH RAID Key	



Control Panel

JFP1 contains header pins for the front control panel connections. All JFP1 wires have been bundled into a single cable to simplify this connection. Make sure the red wire plugs into pin 1 as marked on the motherboard. The other end connects to the control panel PCB board.

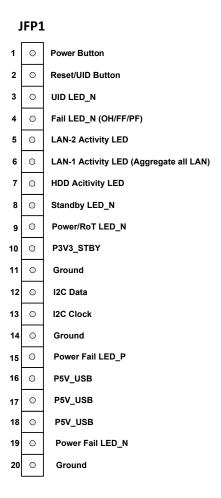


Figure 4-1. JFP1 Control Panel Pins

Power Button and BMC/BIOS Status LED Button

The Power On and BMC/BIOS Status LED button is connected to Pin 1 of the header JFP1. Momentarily contacting Pin 1 of JFP1 will power on/off the system, or display the BMC/BIOS status.

Reset Button/Front UID Switch

The Reset button/Front UID switch is configured in conjunction with the jumper, JRU1. Depending on the JRU1 settings, the button either resets the BMC or toggles the UID LED. See the <u>JRU1 description</u> for details. The button is connected to Pin 2 of JFP1.

UID LED

The unit identifier LED connection is located on Pin 3.

Fail LED (Information LED)

The Fail LED connection is Pin 4 of JFP1. It provides stimulus to the Information LED that indicates overheating, fan failure, and power failure. A description of the <u>Information LED</u> can be found in Chapter 1.

LAN1/LAN2 (NIC1/NIC2)

The NIC (Network Interface Controller) LED connection for LAN Port 1 is Pin 6, and for LAN Port 2 is Pin 5. When this LED is blinking green, it indicates LAN activity.

HDD Activity LED

The HDD activity LED connection is Pin 7. When this LED is blinking green, it indicates HDD activity.

Standby Power LED

The LED indicator for standby power is Pin 8. If this LED is on, standby power is on.

RoT (Root of Trust) Power LED

The Power LED for RoT (Root of Trust) connection is I Pin 9. If this LED is on, power for the RoT chip is on.

Standby Power

A Standby Power (I2C) connections are Pins 10 through Pin 14 to provide power to the system when it is in standby mode.

Power Fail LED Indicators

Power Failure LED Indicators are Pin 15 and Pin 19.

FP USB Power

Front Panel USB power connections are Pins 16 through Pin 18 to provide power to front USB devices.

4.3 Rear I/O Connectors

Advanced I/O Module (AIOM) Connectors for Rear I/O Support

Two Supermicro proprietary Advanced I/O Module (AIOM) connectors used for PCIe 5.0 x16 add-on modules are located at P1-AIOM (J139, supported by CPU1) and P2-AIOM (J7, supported by CPU2). The two AIOM connectors provide input/output connections on the rear side of your system.

Rear I/O Module Connector

An Supermicro proprietary rear I/O module connector is located at JSB1 on the motherboard. This connector provides support for rear I/O module connection.

Connectors/Ports on the AOM-DSF-IO

BMC LAN Port

A dedicated BMC LAN port (BMC_LAN) is located on the AOM-DSF-IO. The dedicated BMC LAN port provides LAN support for the Baseboard Management Controller (BMC). Connect an RJ45 cable to this LAN port for BMC LAN support.

COM Header

One COM header that supports serial link interface is on the AOM-DSF-IO. This COM header is located at COM1.

I/O Module Connector

An I/O module connector is located at JSB2 on the AOM-DSF-IO. Use JSB2 to connect the I/O module to the motherboard.

Universal Serial Bus (USB) Ports

There are two USB 3.0 ports (USB0, USB1) on the AOM-DSF-IO. These USB ports can be used for USB support via USB cables (not included).

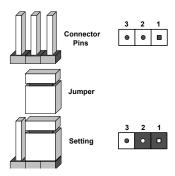
VGA Connections

There is one VGA connection in your system. The rear VGA connection is located at VGA on the AOM-DSF-IO. The VGA connection provides analog interface support between the computer and the video displays.

4.4 Jumpers

To modify the operation of the motherboard, jumpers are used to choose between optional settings. Jumpers create shorts between two pins to change the function associated with it. Pin 1 is identified with a square solder pad on the printed circuit board. See the motherboard layout page for jumper locations.

Note: On a two-pin jumper, "Closed" means the jumper is on both pins and "Open" indicates the jumper is either on only one pin or has been completely removed.



CMOS Clear

JBT1 is used to clear CMOS. See Section 7.7 for details.

UID and System Reset Button Select Jumper

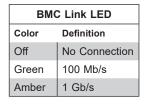
Jumper JRU1 is used to configure the function of the Control Panel Reset or UID LED button (Pin 2 of JFP1). To set the button to toggle the UID LEDs (in a chassis that supports front UID), close Pins 1 and 2 of jumper JRU1. To set the button to reset the system, close Pins 3 and 4 of jumper JRU1.

Front UID Switch/Reset Button Select Jumper (JRU1) Jumper Settings		
State	Description	
Close Pin 1 and Pin 2 of JRU1	Button UID support (Default)	
Close Pin 3 and Pin 4 of JRU1	Button system reset support	

4.5 LED Indicators

BMC-Dedicated LAN LEDs

The AOM-DSF-IO provides a dedicated BMC LAN port provided a connection to the BMC. The Link LED indicates the speed of the connection. The other LED indicates activity.





Unit ID LED

A rear unit identifier (UID) indicator at LED1 on the AOM-DSF-IO. It provides easy identification of a unit that may need service.

Onboard Power LED

The Onboard Power LED is LEDPWR. When this LED is on, the system power is connected.

BMC Heartbeat LED

LEDMBMC is the BMC heartbeat LED. When the LED is blinking green, BMC is functioning normally.

Chapter 5

Software

After the hardware has been installed, you can install the Operating System (OS), configure RAID settings and install the drivers.

5.1 Driver Installation

The Supermicro website contains drivers and utilities for your system at https://www.supermicro.com/wdl/driver. Some of these must be installed, such as the chipset driver.

After accessing the website, go into the CDR_Images (in the parent directory of the above link) and locate the ISO file for your motherboard. Download this file to a USB flash or media drive. (You may also use a utility to extract the ISO file if preferred.)

Another option is to go to the Supermicro website at www.supermicro.com Products. Find the product page for your motherboard, and "Download the Latest Drivers and Utilities".

Insert the flash drive or disk and the screenshot shown below should appear.

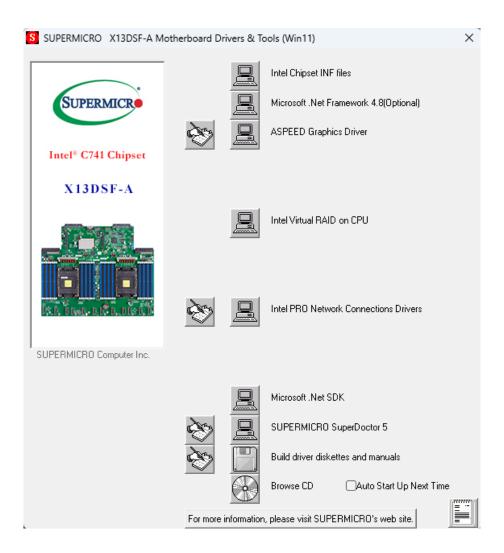


Figure 5-1. Driver and Tool Installation Screen

Note: Click the icons showing a hand writing on paper to view the readme files for each item. Click the computer icons to the right of these items to install each item (from top to the bottom) one at a time. **After installing each item, you must re-boot the system before moving on to the next item on the list.** The bottom icon with a CD on it allows you to view the entire contents.

5.2 BMC

The motherboard provides remote access, monitoring and management through the baseboard management controller (BMC) and other management controllers distributed among different system modules. There are several BIOS settings that are related to BMC. For general documentation and information on BMC, visit our website at: www.supermicro.com/en/solutions/management-software/bmc-resources

BMC ADMIN User Password

For security, each system is assigned a unique default BMC password for the ADMIN user. This can be found on a sticker on the chassis and a sticker on the motherboard. The sticker also displays the BMC MAC address.



Figure 5-2. BMC Password Label

The sticker can be found on the pull-out service tag at the front of the chassis. See Chapter 1 for the location.

Chapter 6

Optional Components

This chapter describes optional system components and installation procedures.

6.1 Storage Control Card and Cable(s)

Supermicro offers storage controller cards for various data protection and drive RAID levels. Refer to the product page for the latest cards and add-on options.

6.2 TPM Security Module

SPI capable TPM 2.0 (or 1.2) with Infineon 9670 controller, horizontal form factor

The JTPM1 header is used to connect a Trusted Platform Module (TPM). A TPM is a security device that supports encryption and authentication in drives. It enables the motherboard to deny access if the TPM associated with the drive is not installed in the system.

Details and installation procedures are at:

http://www.supermicro.com/manuals/other/TPM.pdf.

- AOM-TPM-9670H
- AOM-TPM-9671H

6.3 Intel Virtual RAID on CPU (VROC)

Intel® Virtual RAID on CPU (Intel VROC) is an enterprise RAID solution for NVMe SSDs directly attached to Intel Xeon Scalable processors. Intel Volume Management Device (VMD) is an integrated controller inside the CPU PCIe root complex.

- A single processor supports up to 12 NVMe SSDs and up to 6 RAID arrays.
- A dual processor system supports up to 24 NVMe SSDs and 12 RAID arrays.

Stripe sizes are 4K, 8K, 16K, 32K, 64K, 128K.

Requirements and Restrictions

- Intel VROC is only available when the system is configured for UEFI boot mode.
- To enable the **mdadm** command and support for RSTe, install the patch from
 - Linux: <a href="https://downloadcenter.intel.com/download/28158/Intel-Virtual-RAID-on-CPU-In-tel-VROC-and-Intel-Rapid-Storage-Technology-enterprise-Intel-RSTe-Driver-for-Linux-tel-VROC-and-Intel-Rapid-Storage-Technology-enterprise-Intel-RSTe-Driver-for-Linux-tel-VROC-and-Intel-Rapid-Storage-Technology-enterprise-Intel-RSTe-Driver-for-Linux-tel-VROC-and-Intel-Rapid-Storage-Technology-enterprise-Intel-RSTe-Driver-for-Linux-tel-VROC-and-Intel-Rapid-Storage-Technology-enterprise-Intel-RSTe-Driver-for-Linux-tel-VROC-and-Intel-Rapid-Storage-Technology-enterprise-Intel-RSTe-Driver-for-Linux-tel-VROC-and-Intel-Rapid-Storage-Technology-enterprise-Intel-RSTe-Driver-for-Linux-tel-VROC-and-Intel-Rapid-Storage-Technology-enterprise-Intel-Rapid-Storage-Intel-Rapid-Storage-Intel-Rapid-Storage-Intel-Rapid-Storage-Intel-Rapid-Stora
 - Windows: https://downloadcenter.intel.com/download/28108/Intel-Virtual-RAID-on-CPU-Intel-VROC-and-Intel-Rapid-Storage-Technology-enterprise-Intel-RSTe-Driver-for-Windows-
- To enable Intel VROC, a hardware key must be inserted on the motherboard, and the appropriate processor's Virtual Management Devices must be enabled in the BIOS setup.
- It is possible to enable Intel VROC without a hardware key installed, but only RAID0 will be enabled.
- Intel VROC is not compatible with secure boot. This feature must be disabled.
- When creating bootable OS RAID1 devices, you must have both devices on the same CPU, and a VMD on that CPU.
- Spanning drives when creating RAID devices is not recommended to due to performance issues, even though it is supported.

Supported SSDs and Operating Sytems

To see the latest support information: https://www.intel.com/content/www/us/en/support/articles/000030310/memory-and-storage/ssd-software.html

Additional Information

Additional information is available on the product page for the Supermicro add-on card and the linked manuals.

www.supermicro.com/products/accessories/addon/AOC-VROCxxxMOD.cfm

Hardware Key

The Intel VROC hardware key is a license key that detects the Intel VROC SKU and activates the function accordingly. The key must be plugged into the Supermicro motherboard (connector JRK1). The key options are:

Intel® VROC Keys				
VROC Package	Description	Part Number	Intel MM Number	
Standard	RAID 0, 1, 10 Supports 3rd party SSDs	AOC-VROCSTNMOD	951605	
Premium	RAID 0, 1, 5, 10 Supports 3rd party SSDs	AOC-VROCPREMOD	951606	
Intel SSD only	RAID 0, 1, 5, 10 Supports Intel SSDs only	AOC-VROCINTMOD	956822	

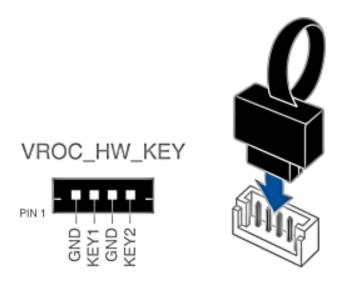


Figure 6-1. Intel VROC RAID Key and Motherboard Connector JRK1

Configuring NVMe RAID Manually

RAID for NVMe SSDs is enabled by default when Intel VROC Raid Key is populated. It may be managed manually through the UEFI BIOS.

- 1. Reboot the server and press [DEL] key to access the BIOS options.
- 2. Switch to Advanced > Chipset Configuration > North Bridge > IIO Configuration > Intel® VMD Technology.

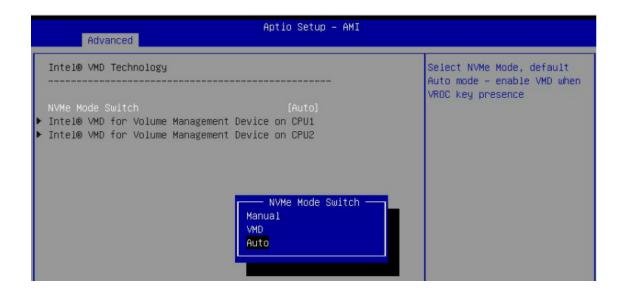


Figure 6-2. BIOS, Selecting VMD Mode

You can select a mode. The default is **Auto**. The **VMD** switch enables VMD mode for all NVMe ports despite the presence of the VROC key. The **Manual** switch allows the user to choose devices on which to enable VMD.

The onboard M.2 NVMe from PCH is located in the CPU1 section.

The screenshot below show example choices in Manual mode.

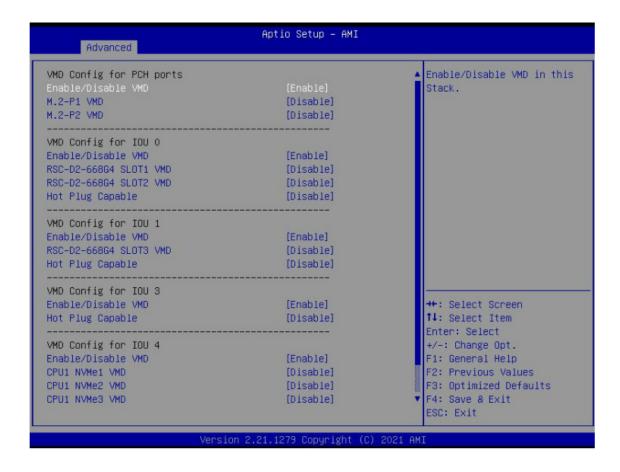


Figure 6-3. BIOS, Manual Mode (Example—your server may look different.)

3. Select the desired PStack# to Enable or Disable the corresponding Intel VMD controller

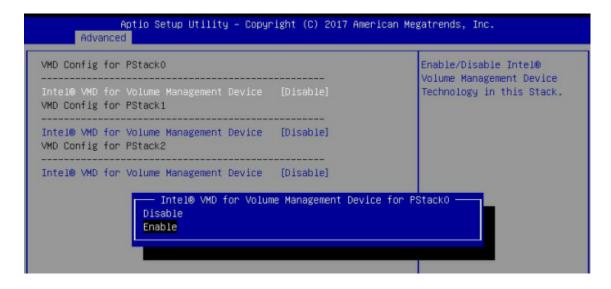


Figure 6-4. BIOS, Enabling VMD for Pstack0

 Select the desired PCIe slot to Enable or Disable Intel VMD functionality according to the current hardware configuration being used. Hot Plug Capability can also be Enabled or Disabled.



Figure 6-5. BIOS, Enabling VMD Functionality per Slot

5. Repeat steps 3 and 4 for each PStack# on each CPU to be enabled or disabled. In this example, we enabled CPU1 Slot1 (Figure 6-11) and CPU2 Slot5 (Figure 6-12) (four U.2 form factor SSDs), as well as CPU1 M.2 C-1 and CPU1 M2. C-2 (two M.2 form factor SSDs)

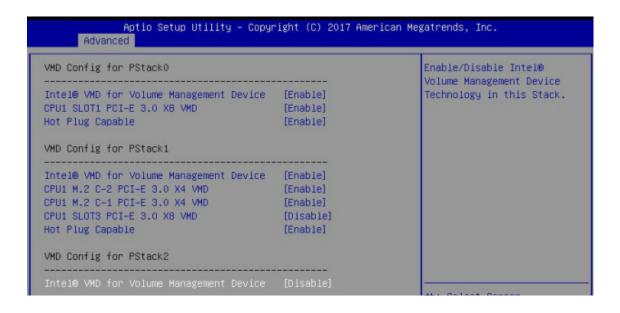


Figure 6-6. BIOS, Enabling CPU1 Example

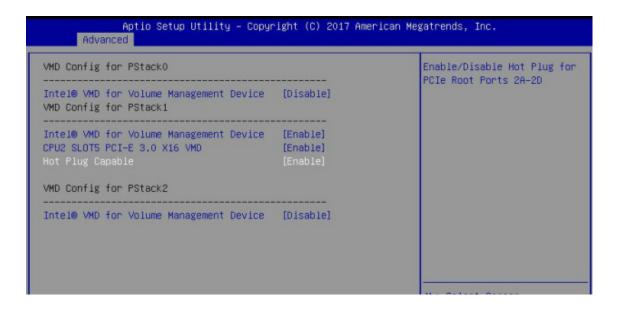


Figure 6-7. BIOS, Enabling CPU2 Example

6. Press [F4] to save the configuration and reboot the system and press [DEL] to enter BIOS.

Note: Disabling the VMD controller without first deleting the associated existing RAID volume can lead to unexpected behavior. This action is strongly not recommended.

Note: The effects of physically changing or swapping a CPU on the VMD controller enablement has not yet been thoroughly tested or documented.

- 7. Switch to Advanced > Intel(R) Virtual RAID on CPU > All Intel VMD Controllers > Create RAID Volume.
- 8. Set Name.
- 9. Set RAID Level.

10. If cross-controller RAID is required, select **Enable RAID spanned over VMD Controller**.

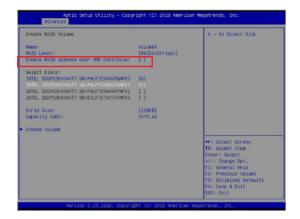


Figure 6-8. Created Volume without enabling RAID spanned over VMD controller



Figure 6-9. Created Volume with enabling RAID spanned over VMD controller

- 11. Select specific disks for RAID with an [X].
 - RAID0: Select at least two [2 24] disks
 - RAID1: Select only two disks
 - RAID5: Select at least three [3 24] disks
 - RAID10: Select only four disks
- 12. Select Strip Size (Default 64KB).
- 13. Select Create Volume.
- 14. If another RAID is needed, start again at step 9.
- 15. Press [F4] to save and reboot.

Status Indications

An LED indicator on the drive carrier shows the RAID status of the drive.

Drive Carrier Status LED Indicator			
Status	State (red)		
Normal function	Off		
Locating	4 Hz blinking		
Fault	Solid on		
Rebuilding	1 Hz blinking		

IBPI SFF 8489 Defined Status LED States

Hot Swap Drives

Intel VMD enables hot-plug and hot-unplug for NVMe SSDs, whether from Intel or other manufacturers. Under vSphere ESXi, several steps are necessary to avoid potential stability issues. See the information at link [1] below.

Hot-unplug

1. Prevent devices from being re-detected during rescan:

```
esxcli storage core claiming autoclaim --enabled=false
```

- 2. Unmount the VMFS volumes on the device. Check [2] for details.
- 3. Detach the device. Check [3] for details.
- 4. Physically remove the device.

Hot-plug

· Physically install the device.

ESXi will automatically discover NVMe SSDs, but a manual scan may be required in some cases.

Related Information Links

- [1] https://kb.vmware.com/s/article/2151404
- [2] https://docs.vmware.com/en/VMware-vSphere/6.5/com.vmware.vsphere.storage.doc/GUID-1B56EF97-F60E-4F21-82A7-8F2A7294604D.html
- [3] https://docs.vmware.com/en/VMware-vSphere/6.5/com.vmware.vsphere.storage.doc/ GUID-F2E75F67-740B-4406-9F0C-A2D99A698F2A.html

Chapter 7

Troubleshooting and Support

7.1 Information Resources

Website

A great deal of information is available on the Supermicro website, supermicro.com.



Figure 7-1. Supermicro Website

- Specifications for servers and other hardware are available by clicking the Products option.
- The **Support** option offers downloads (manuals, BIOS/BMC, drivers, etc.), FAQs, RMA, warranty, and other service extensions.

Direct Links

System SSG-121E-NE3X12R web page

Motherboard X13DSF-A <u>web page</u> for links to the Quick Reference Guide, User Manual, validated storage drives, etc.

Direct Links for General Support and Information

Frequently Asked Questions

TPM User Guide

BMC User Guide

SuperDoctor5 Large Deployment Guide

For validated memory, use our Product Resources page

Direct Links (continued)

<u>Product Matrices</u> page for links to tables summarizing specs for systems, motherboards, power supplies, riser cards, add-on cards, etc.

Security Center for recent security notices

Supermicro Phone and Addresses

7.2 BMC Interface

The system supports a Baseboard Management Controller (BMC) interface. It provides remote access, monitoring and management. There are several BIOS settings related to the BMC.

For general documentation and information on the BMC, please visit our website at: https://www.supermicro.com/manuals/other/BMC_IPMI_X13_H13.pdf.

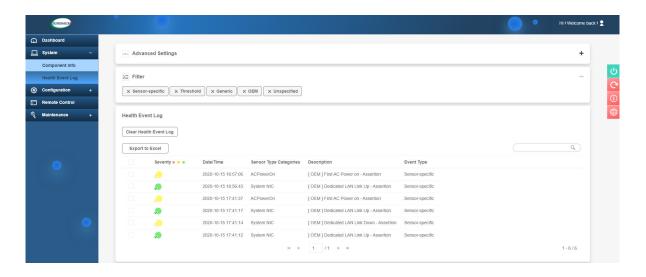


Figure 7-2. BMC Dashboard Sample

7.3 Troubleshooting Procedures

Use the following procedures to troubleshoot your system. If you have followed all of the procedures below and still need assistance, refer to the <u>Technical Support Procedures</u> or <u>Returning Merchandise for Service</u> sections in this chapter. <u>Power down</u> the system before changing any non hot-swap hardware components.

General Technique

If you experience unstable operation or get no boot response, try:

- 1. With power off, remove all but one DIMM and other added components, such as add-on cards, from the motherboard. Make sure the motherboard is not shorted to the chassis.
- 2. Set all jumpers to their default positions.
- 3. Power up. If the system boots, check for memory errors and add-on card problems.

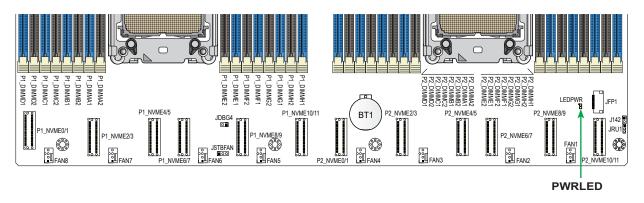


Figure 7-3. Location of the MB Power LED

No Power

- Check that the power LED on the motherboard is on.
- Make sure that the power connector is connected to the power supply.
- Check that the motherboard battery still supplies approximately 3VDC. If it does not, replace it.
- Check that the system input voltage is 100-120v or 180-240v.
- Turn the power switch on and off to test the system

No Video

If the power is on but you have no video, remove all add-on cards and cables.

System Boot Failure

If the system does not display Power-On-Self-Test (POST) or does not respond after the power is turned on, try the following:

 Turn on the system with only one DIMM module installed. If the system boots, check for bad DIMM modules or slots by following the Memory Errors Troubleshooting procedure below.

Memory Errors

- Make sure that the DIMM modules are properly and fully installed.
- Confirm that you are using the correct memory. Also, it is recommended that you use the same memory type and speed for all DIMMs in the system. See Section 3.3 for memory details.
- Check for bad DIMM modules or slots by swapping modules between slots and noting the results.

Losing the System Setup Configuration

- Always replace power supplies with the exact same model that came with the system. A
 poor quality power supply may cause the system to lose the CMOS setup configuration.
- Check that the motherboard battery still supplies approximately 3VDC. If it does not, replace it.

If the above steps do not fix the setup configuration problem, contact your vendor for repairs.

When the System Becomes Unstable

If the system becomes unstable during or after OS installation, check the following:

- CPU/BIOS support: Make sure that your CPU is supported and that you have the latest BIOS installed in your system.
- Memory: Make sure that the memory modules are supported. Refer to the product page on our website at www.supermicro.com. Test the modules using memtest86 or a similar utility.
- Storage drives: Make sure that all drives work properly. Replace if necessary.
- System cooling: Check that all heatsink fans and system fans work properly. Check the hardware monitoring settings in the BMC to make sure that the CPU and system temperatures are within the normal range. Also check the Control panel Overheat LED.

- Adequate power supply: Make sure that the power supply provides adequate power to the system. Make sure that all power connectors are connected. Refer to the Supermicro website for the minimum power requirements.
- Proper software support: Make sure that the correct drivers are used.

If the system becomes unstable before or during OS installation, check the following:

- Source of installation: Make sure that the devices used for installation are working properly, including boot devices.
- Cable connection: Check to make sure that all cables are connected and working properly.
- Use the minimum configuration for troubleshooting: Remove all unnecessary components (starting with add-on cards first), and use the minimum configuration (but with a CPU and a memory module installed) to identify the trouble areas.
- Identify a bad component by isolating it. Check and change one component at a time.
 - Remove a component in question from the chassis, and test it in isolation. Replace it
 if necessary.
 - Or swap in a new component for the suspect one.
 - Or install the possibly defective component into a known good system. If the new system works, the component is likely not the cause or the problem.

7.4 POST Codes

The AMI UEFI BIOS supplies checkpoint codes, which are documented online at http://www.supermicro.com/support/manuals/ ("AMI BIOS POST Codes User's Guide").

When BIOS performs the Power On Self Test, it writes checkpoint codes to I/O port 0080h. If the computer cannot complete the boot process, the POST codes can be viewed from the BMC using the Post Snooping function.

For information on AMI updates, please refer to http://www.ami.com/products/.

7.5 Crash Dump Using the BMC Dashboard

In the event of a processor internal error (IERR) that crashes your system, you may want to provide information to support staff. You can download a crash dump of status information using the BMC Dashboard. The BMC manual is available at https://www.supermicro.com/manuals/other/BMC IPMI X13 H13.pdf.

Check Error Log

- 1. Access the BMC web interface.
- 2. Click the **Server Health** tab, then **Event Log** to verify an IERR error.

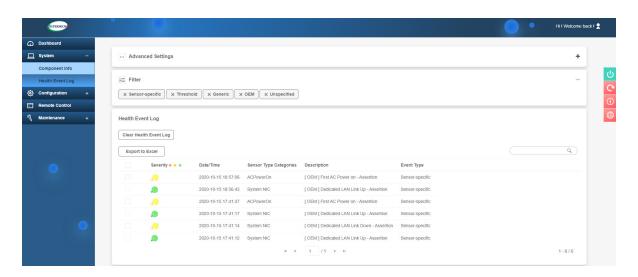


Figure 7-4. BMC Event Log

In the event of an IERR, the BMC executes a crash dump. You must download the crash dump and save it.

7.6 UEFI BIOS Recovery

Warning: Do not upgrade the BIOS unless your system has a BIOS-related issue. Flashing the wrong BIOS can cause irreparable damage to the system. In no event shall Supermicro be liable for direct, indirect, special, incidental, or consequential damages arising from a BIOS update. If you do update the BIOS, do not shut down or reset the system while the BIOS is updating to avoid possible boot failure.

Overview

The Unified Extensible Firmware Interface (UEFI) provides a software-based interface between the operating system and the platform firmware in the pre-boot environment. The UEFI specification supports an architecture-independent mechanism that will allow the UEFI OS loader stored in an add-on card to boot the system. The UEFI offers clean, hands-off management to a computer during system boot.

Recovering the UEFI BIOS Image

A UEFI BIOS flash chip consists of a recovery BIOS block and a main BIOS block (a main BIOS image). The recovery block contains critical BIOS codes, including memory detection and recovery codes for the user to flash a healthy BIOS image if the original main BIOS image is corrupted. When the system power is turned on, the recovery block codes execute first. Once this process is complete, the main BIOS code will continue with system initialization and the remaining POST (Power-On Self-Test) routines.

Note 1: Follow the BIOS recovery instructions below for BIOS recovery when the main BIOS block crashes.

Note 2: When the BIOS recovery block crashes, you will need to follow the procedures to make a Returned Merchandise Authorization (RMA) request. Also, you may use the Supermicro Update Manager (SUM) Out-of-Band (https://www.supermicro.com.tw/products/nfo/SMS_SUM.cfm) to reflash the BIOS.

Recovering the Main BIOS Block with a USB Device

This feature allows the user to recover the main BIOS image using a USB-attached device without additional utilities used. A USB flash device such as a USB Flash Drive, or a USB CD/DVD ROM/RW device can be used for this purpose. However, a USB Hard Disk drive cannot be used for BIOS recovery at this time.

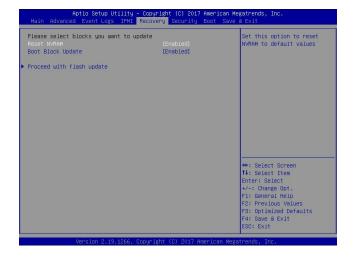
The file system supported by the recovery block is FAT (including FAT12, FAT16, and FAT32) which is installed on a bootable or non-bootable USB-attached device. However, the BIOS might need several minutes to locate the SUPER.ROM file if the media size becomes too large due to the huge volumes of folders and files stored in the device.

To perform UEFI BIOS recovery using a USB-attached device, follow the instructions below.

- 1. Using a different machine, copy the "Super.ROM" binary image file into the Root "\" directory of a USB device or a writable CD/DVD.
 - **Note 1:** If you cannot locate the "Super.ROM" file in your drive disk, visit our website at www.supermicro.com to download the BIOS package. Extract the BIOS binary image into a USB flash device and rename it "Super.ROM" for the BIOS recovery use.
 - **Note 2:** Before recovering the main BIOS image, confirm that the "Super.ROM" binary image file you download is the same version or a close version meant for your motherboard.
- 2. Insert the USB device that contains the new BIOS image ("Super.ROM") into your USB drive and reset the system when the following screen appears.
- 3. After locating the healthy BIOS binary image, the system will enter the BIOS Recovery menu as shown below.



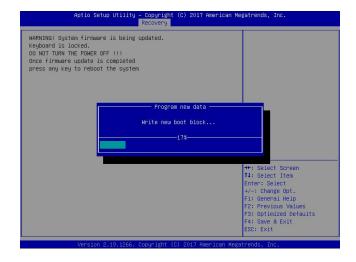
Note: At this point, you may decide if you want to start the BIOS recovery. If you decide to proceed with BIOS recovery, follow the procedures below.



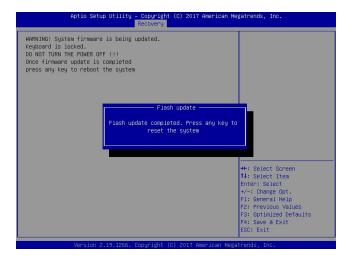
4. When the screen as shown above displays, use the arrow keys to select the item "Proceed with flash update" and press the <Enter> key. You will see the BIOS recovery progress as shown in the screen below.

Note: <u>Do not interrupt the BIOS flashing process until it has completed</u>.

- 5. After the BIOS recovery process is complete, press any key to reboot the system.
- 6. Using a different system, extract the BIOS package into a USB flash drive.

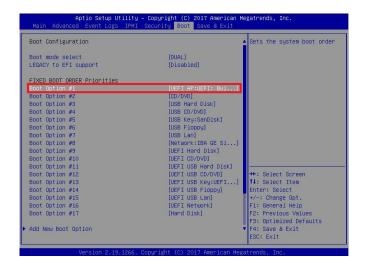


7. Press continuously during system boot to enter the BIOS Setup utility. From the top of the tool bar, select Boot to enter the submenu. From the submenu list, select Boot



Option #1 as shown below. Then, set Boot Option #1 to [UEFI AP:UEFI: Built-in EFI Shell]. Press <F4> to save the settings and exit the BIOS Setup utility.

8. When the UEFI Shell prompt appears, type fs# to change the device directory path. Go to the directory that contains the BIOS package you extracted earlier from Step 6. Enter flash.nsh BIOSname.### at the prompt to start the BIOS update process.



Note: <u>Do not interrupt this process</u> until the BIOS flashing is complete.

```
UEST Interactive Shell V2.1

ERV II

UEST v2.50 (Smerican Megatrends, 0x0005000C)

Hopolar table

FSD: Allas (s):H000rdb::BUL1:

PE:RROUT (xx0) /PE:(0x14,0x0) /USB(0x11,0x0) /H0(1,MBR,0x37901072,0x800,0x1

DASSE2)

BLUG: Allas (s):

PE:RROUT (xx0) /PE:(0x14,0x0) /USB(0x11,0x0)

Phess EED in 1 seconds to skip stertup.nsh or any other key to continue.

Shell FSD:

SPO:NGFUDOSYSHIPHEZ.03182017:

FSO:NGFUDOSYSHIPHEZ.03182017:

FSO:NGFUDOSYSHIPHEZ.03182017:

FSO:NGFUDOSYSHIPHEZ.03182017:
```

9. The screen above indicates that the BIOS update process is complete. When you see the screen above, unplug the AC power cable from the power supply, clear CMOS, and plug

the AC power cable in the power supply again to power on the system.

10. Press continuously to enter the BIOS Setup utility.

- 11. Press <F3> to load the default settings.
- 12. After loading the default settings, press <F4> to save the settings and exit the BIOS Setup utility.

7.7 CMOS Clear

JBT1 is used to clear CMOS, which will also clear any passwords. Instead of pins, this jumper consists of contact pads to prevent accidentally clearing the contents of CMOS.

To Clear CMOS

- 1. First power down the system completely.
- 2. Remove the cover of the chassis to access the motherboard.
- 3. Remove the onboard battery from the motherboard.
- 5. Remove the screwdriver or shorting device.
- 6. Replace the cover, reconnect the power cords and power on the system.

Notes: Clearing CMOS will also clear all passwords.

Do not use the PW_ON connector to clear CMOS.

7.8 BMC Reset

The BMC can be reset using the UID button. First, move the JRU1 jumper to pins 3/4 (see Section 4.4).

- Reset Press and hold the button. After six seconds, the LED blinks at 2Hz. The BMC resets and the reset duration is approximately 250 ms. Then the BMC starts to boot.
- Restore factory default configuration Hold the button for twelve seconds. The LED blinks
 at 4Hz while defaults are configured. Note: All BMC settings including username and
 password will be removed except the FRU and network settings.

Firmware update – When the BMC firmware is being updated, the UID LED blinks at 10Hz.

BMC Reset Options				
Event	UID LED	BMC Heartbeat LED		
Reset	Blue, Blinks at 2 Hz	Green, solid		
Restore Defaults	Blue, Blinking at 4 Hz	Off		
Update	Blue, Blinking at 10 Hz			

7.9 Where to Get Replacement Components

If you need replacement parts for your system, to ensure the highest level of professional service and technical support, purchase exclusively from our Supermicro Authorized Distributors/System Integrators/Resellers. A list can be found at: http://www.supermicro.com. Click the "Where to Buy" tab.

7.10 Reporting an Issue

Technical Support Procedures

Before contacting Technical Support, please take the following steps. If your system was purchased through a distributor or reseller, please contact them for troubleshooting services. They have the best knowledge of your specific system configuration.

- Please review the <u>Troubleshooting Procedures</u> in this manual and <u>Frequently Asked</u> <u>Questions</u> on our website before contacting Technical Support.
- 2. BIOS upgrades can be downloaded from our website. **Note**: Not all BIOS can be flashed depending on the modifications to the boot block code.
- 3. If you still cannot resolve the problem, include the following information when contacting us for technical support:
 - System, motherboard, and chassis model numbers and PCB revision number
 - BIOS release date/version (this can be seen on the initial display when your system first boots up)
 - System configuration

An example of a Technical Support form is posted on our <u>website</u>. Distributors: For immediate assistance, please have your account number ready when contacting our technical support department by email.

Returning Merchandise for Service

A receipt or copy of your invoice marked with the date of purchase is required before any warranty service will be rendered. You can obtain service by calling your vendor for a Returned Merchandise Authorization (RMA) number. When returning to the manufacturer, the RMA number should be prominently displayed on the outside of the shipping carton, and mailed prepaid or hand-carried. Shipping and handling charges will be applied for all orders that must be mailed when service is complete.

For faster service, RMA authorizations may be requested online (http://www.supermicro.com/support/rma/).

Whenever possible, repack the chassis in the original Supermicro carton, using the original packaging material. If these are no longer available, be sure to pack the chassis securely, using packaging material to surround the chassis so that it does not shift within the carton and become damaged during shipping.

This warranty only covers normal consumer use and does not cover damages incurred in shipping or from failure due to the alteration, misuse, abuse or improper maintenance of products.

During the warranty period, contact your distributor first for any product problems.

Vendor Support Filing System

For issues related to Intel, use the Intel IPS filing system:

https://www.intel.com/content/www/us/en/design/support/ips/training/welcome.html

For issues related to Red Hat Enterprise Linux, since it is a subscription based OS, contact your account representative.

7.11 Feedback

Supermicro values your feedback as we strive to improve our customer experience in all facets of our business. To provide feedback on our manuals, please email us at techwriterteam@supermicro.com.

7.12 Contacting Supermicro

Headquarters

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San Jose, CA 95131 U.S.A.

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Government_Sales-USA@supermicro.com (Gov. Sales Inquiries)

support@supermicro.com (Technical Support)

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Support@supermicro.com.tw (Technical Support)

RMA@supermicro.com.tw (RMA Support)

Website: www.supermicro.com.tw

Appendix A

Standardized Warning Statements for AC Systems

About Standardized Warning Statements

The following statements are industry standard warnings, provided to warn the user of situations which have the potential for bodily injury. Should you have questions or experience difficulty, contact Supermicro's Technical Support department for assistance. Only certified technicians should attempt to install or configure components.

Read this appendix in its entirety before installing or configuring components in the Supermicro chassis.

These warnings may also be found on our website at http://www.supermicro.com/about/policies/safety_information.cfm.

Warning Definition



Warning! This warning symbol means danger. You are in a situation that could cause bodily injury. Before you work on any equipment, be aware of the hazards involved with electrical circuitry and be familiar with standard practices for preventing accidents.

警告の定義

この警告サインは危険を意味します。

人身事故につながる可能性がありますので、いずれの機器でも動作させる前に、

電気回路に含まれる危険性に注意して、標準的な事故防止策に精通して下さい。

此警告符号代表危险。

您正处于可能受到严重伤害的工作环境中。在您使用设备开始工作之前,必须充分意识到触电的危险,并熟练掌握防止事故发生的标准工作程序。请根据每项警告结尾的声明号码找到此设备的安全性警告说明的翻译文本。

此警告符號代表危險。

您正處於可能身體可能會受損傷的工作環境中。在您使用任何設備之前,請注意觸電的危險,並且要熟悉預防事故發生的標準工作程序。請依照每一注意事項後的號碼找到相關的翻譯說明 內容。

Warnung

WICHTIGE SICHERHEITSHINWEISE

Dieses Warnsymbol bedeutet Gefahr. Sie befinden sich in einer Situation, die zu Verletzungen führen kann. Machen Sie sich vor der Arbeit mit Geräten mit den Gefahren elektrischer Schaltungen und den üblichen Verfahren zur Vorbeugung vor Unfällen vertraut. Suchen Sie mit der am Ende jeder Warnung angegebenen Anweisungsnummer nach der jeweiligen Übersetzung in den übersetzten Sicherheitshinweisen, die zusammen mit diesem Gerät ausgeliefert wurden.

BEWAHREN SIE DIESE HINWEISE GUT AUF.

INSTRUCCIONES IMPORTANTES DE SEGURIDAD

Este símbolo de aviso indica peligro. Existe riesgo para su integridad física. Antes de manipular cualquier equipo, considere los riesgos de la corriente eléctrica y familiarícese con los procedimientos estándar de prevención de accidentes. Al final de cada advertencia encontrará el número que le ayudará a encontrar el texto traducido en el apartado de traducciones que acompaña a este dispositivo.

GUARDE ESTAS INSTRUCCIONES.

IMPORTANTES INFORMATIONS DE SÉCURITÉ

Ce symbole d'avertissement indique un danger. Vous vous trouvez dans une situation pouvant entraîner des blessures ou des dommages corporels. Avant de travailler sur un équipement, soyez conscient des dangers liés aux circuits électriques et familiarisez-vous avec les procédures couramment utilisées pour éviter les accidents. Pour prendre connaissance des traductions des avertissements figurant dans les consignes de sécurité traduites qui accompagnent cet appareil, référez-vous au numéro de l'instruction situé à la fin de chaque avertissement.

CONSERVEZ CES INFORMATIONS.

תקנון הצהרות אזהרה

הצהרות הבאות הן אזהרות על פי תקני התעשייה, על מנת להזהיר את המשתמש מפני חבלה פיזית אפשרית. במידה ויש שאלות או היתקלות בבעיה כלשהי, יש ליצור קשר עם מחלקת תמיכה טכנית של סופרמיקרו. טכנאים מוסמכים בלבד רשאים להתקין או להגדיר את הרכיבים. יש לקרוא את הנספח במלואו לפני התקנת או הגדרת הרכיבים במארזי סופרמיקרו.

ا كَ ف حالة وُكِي أَى تتسبب ف اصابة جسذ ةٌ هذا الزهز عٌ خطز !تحذ زٌ . قبل أَى تعول على أي هعذات،كي على علن بالوخاطز ال اُجوة عي الذوائز الكهزبائ ة وكي على درا ةٌ بالووارسات اللقائ ة لو عٌ وقع أي حيادث استخذم رقن الب إى الو صُبص ف هًا ةٌ كل تحذ زٌ للعثير تزجوتها

안전을 위한 주의사항

경고!

이 경고 기호는 위험이 있음을 알려 줍니다. 작업자의 신체에 부상을 야기 할 수 있는 상태에 있게 됩니다. 모든 장비에 대한 작업을 수행하기 전에 전기회로와 관련된 위험요소들을 확인하시고 사전에 사고를 방지할 수 있도록 표준 작업절차를 준수해 주시기바랍니다.

해당 번역문을 찾기 위해 각 경고의 마지막 부분에 제공된 경고문 번호를 참조하십시오

BELANGRIJKE VEILIGHEIDSINSTRUCTIES

Dit waarschuwings symbool betekent gevaar. U verkeert in een situatie die lichamelijk letsel kan veroorzaken. Voordat u aan enige apparatuur gaat werken, dient u zich bewust te zijn van de bij een elektrische installatie betrokken risico's en dient u op de hoogte te zijn van de standaard procedures om ongelukken te voorkomen. Gebruik de nummers aan het eind van elke waarschuwing om deze te herleiden naar de desbetreffende locatie.

BEWAAR DEZE INSTRUCTIES

Installation Instructions



Warning! Read the installation instructions before connecting the system to the power source.

設置手順書

システムを電源に接続する前に、設置手順書をお読み下さい。

警告

将此系统连接电源前,请先阅读安装说明。

警告

將系統與電源連接前,請先閱讀安裝說明。

Warnung

Vor dem Anschließen des Systems an die Stromquelle die Installationsanweisungen lesen.

¡Advertencia!

Lea las instrucciones de instalación antes de conectar el sistema a la red de alimentación.

Attention

Avant de brancher le système sur la source d'alimentation, consulter les directives d'installation.

יש לקרוא את הוראות התקנה לפני חיבור המערכת למקור מתח.

اقر إرشادات التركيب قبل توصيل النظام إلى مصدر للطاقة

시스템을 전원에 연결하기 전에 설치 안내를 읽어주십시오.

Waarschuwing

Raadpleeg de installatie-instructies voordat u het systeem op de voedingsbron aansluit.

Circuit Breaker



Warning! This product relies on the building's installation for short-circuit (overcurrent) protection. Ensure that the protective device is rated not greater than: 250 V, 20 A.

サーキット・ブレーカー

この製品は、短絡(過電流)保護装置がある建物での設置を前提としています。

保護装置の定格が250 V、20 Aを超えないことを確認下さい。

警告

此产品的短路(过载电流)保护由建筑物的供电系统提供,确保短路保护设备的额定电流不大于 250V,20A。

警告

此產品的短路(過載電流)保護由建築物的供電系統提供,確保短路保護設備的額定電流不大於 250V,20A。

Warnung

Dieses Produkt ist darauf angewiesen, dass im Gebäude ein Kurzschluss- bzw. Überstromschutz installiert ist. Stellen Sie sicher, dass der Nennwert der Schutzvorrichtung nicht mehr als: 250 V, 20 A beträgt.

¡Advertencia!

Este equipo utiliza el sistema de protección contra cortocircuitos (o sobrecorrientes) del edificio. Asegúrese de que el dispositivo de protección no sea superior a: 250 V, 20 A.

Attention

Pour ce qui est de la protection contre les courts-circuits (surtension), ce produit dépend de l'installation électrique du local. Vérifiez que le courant nominal du dispositif de protection n'est pas supérieur à :250 V, 20 A.

מוצר זה מסתמך על הגנה המותקנת במבנים למניעת קצר חשמלי. יש לוודא כי מוצר זה מסתמך על הגנה החשמלי הוא לא יותר מ-250VDC, 20A

هذا المنتج يعتمد على معداث الحمايت مه الدوائرالقصيرة التي تم تثبيتها في المبنى تقديم الحهاز الوقائي ليس أكثر من : 20A, 250V

경고!

이 제품은 전원의 단락(과전류)방지에 대해서 전적으로 건물의 관련 설비에 의존합니다. 보호장치의 정격이 반드시 250V(볼트), 20A(암페어)를 초과하지 않도록 해야 합니다.

Waarschuwing

Dit product is afhankelijk van de kortsluitbeveiliging (overspanning) van uw electrische installatie. Controleer of het beveiligde aparaat niet groter gedimensioneerd is dan 250V, 20A.

Power Disconnection Warning



Warning! The system must be disconnected from all sources of power and the power cord removed from the power supply module(s) before accessing the chassis interior to install or remove system components (except for hot-swap components).



電源切断の警告

システムコンポーネントの取り付けまたは取り外しのために、シャーシー内部にアクセスするには、 システムの電源はすべてのソースから切断され、電源コードは電源モジュールから取り外す必要が あります。

警告

在你打开机箱并安装或移除内部器件前,必须将系统完全断电,并移除电源线。

警告

在您打開機殼安裝或移除內部元件前,必須將系統完全斷電,並移除電源線。

Warnung

Das System muss von allen Quellen der Energie und vom Netzanschlusskabel getrennt sein, das von den Spg. Versorgungsteilmodulen entfernt wird, bevor es auf den Chassisinnenraum zurückgreift, um Systemsbestandteile anzubringen oder zu entfernen.

¡Advertencia!

El sistema debe ser disconnected de todas las fuentes de energía y del cable eléctrico quitado de los módulos de fuente de alimentación antes de tener acceso el interior del chasis para instalar o para quitar componentes de sistema.

Attention

Le système doit être débranché de toutes les sources de puissance ainsi que de son cordon d'alimentation secteur avant d'accéder à l'intérieur du chassis pour installer ou enlever des composants de système.

אזהרה מפני ניתוק חשמלי

אזהרה!

יש לנתק את המערכת מכל מקורות החשמל ויש להסיר את כבל החשמלי מהספק. לפני גישה לחלק הפנימי של המארז לצורך התקנת או הסרת רכיבים.

يجب فصم اننظاو من جميع مصادر انطاقت وإزانت سهك انكهرباء من وحدة امداد انطاقت قبم اننطاق انداخهيت نههيكم نتثبيج أو إزانت مكنناث الجهاز

경고!

시스템에 부품들을 장착하거나 제거하기 위해서는 섀시 내부에 접근하기 전에 반드시 전원 공급장치로부터 연결되어있는 모든 전원과 전기코드를 분리해주어야 합니다.

Waarschuwing

Voordat u toegang neemt tot het binnenwerk van de behuizing voor het installeren of verwijderen van systeem onderdelen, dient u alle spanningsbronnen en alle stroomkabels aangesloten op de voeding(en) van de behuizing te verwijderen

Equipment Installation



Warning! Only authorized personnel and qualified service persons should be allowed to install, replace, or service this equipment.

機器の設置

トレーニングを受け認定された人だけがこの装置の設置、交換、またはサービスを許可されています。

警告

只有经过培训且具有资格的人员才能进行此设备的安装、更换和维修。

警告

只有經過受訓月具資格人員才可安裝、更換與維修此設備。

Warnung

Nur autorisiertes Personal und qualifizierte Servicetechniker dürfen dieses Gerät installieren, austauschen oder warten..

¡Advertencia!

Sólo el personal autorizado y el personal de servicio calificado deben poder instalar, reemplazar o dar servicio a este equipo.

Attention

Seul le personnel autorisé et le personnel de maintenance qualifié doivent être autorisés à installer, remplacer ou entretenir cet équipement.

!אזהרה

יש לאפשר רק צוות מורשה ואנשי שירות מוסמכים להתקין, להחליף או לטפל בציוד זה.

ينبغى السماح فقط للموظفين المعتمدين وأفراد الخدمة المؤهلين بتركيب هذا الجهاز أو استبداله أو صيانته

경고!

승인된 직원과 자격을 갖춘 서비스 담당자만이 이 장비를 설치, 교체 또는 서비스할 수 있습니다.

Waarschuwing

Alleen geautoriseerd personeel en gekwalificeerd onderhoudspersoneel mag deze apparatuur installeren, vervangen of onderhouden..

Restricted Area



Warning! This unit is intended for installation in restricted access areas. A restricted access area can be accessed only through the use of a special tool, lock and key, or other means of security. (This warning does not apply to workstations).

アクセス制限区域

このユニットは、アクセス制限区域に設置されることを想定しています。

アクセス制限区域は、特別なツール、鍵と錠前、その他のセキュリティの手段を用いてのみ出入りが可能です。

警告

此部件应安装在限制进出的场所,限制进出的场所指只能通过使用特殊工具、锁和钥匙或其它安全手段进出的场所。

警告

此裝置僅限安裝於進出管制區域,進出管制區域係指僅能以特殊工具、鎖頭及鑰匙或其他安全 方式才能進入的區域。

Warnung

Diese Einheit ist zur Installation in Bereichen mit beschränktem Zutritt vorgesehen. Der Zutritt zu derartigen Bereichen ist nur mit einem Spezialwerkzeug, Schloss und Schlüssel oder einer sonstigen Sicherheitsvorkehrung möglich.

¡Advertencia!

Esta unidad ha sido diseñada para instalación en áreas de acceso restringido. Sólo puede obtenerse acceso a una de estas áreas mediante la utilización de una herramienta especial, cerradura con llave u otro medio de seguridad.

Attention

Cet appareil doit être installée dans des zones d'accès réservés. L'accès à une zone d'accès réservé n'est possible qu'en utilisant un outil spécial, un mécanisme de verrouillage et une clé, ou tout autre moyen de sécurité.

אזור עם גישה מוגבלת

!אזהרה

יש להתקין את היחידה באזורים שיש בהם הגבלת גישה. הגישה ניתנת בעזרת 'כלי אבטחה בלבד)מפתח, מנעול וכד.)

تخصيص هذه اندخذة نترك بها ف مناطق محظورة تم . ، مكن اندصل إن منطقت محظورة فقط من خلال استخذاو أداة خاصت أو أوس هُت أخري نلالأمما قفم ومفتاح

경고!

이 장치는 접근이 제한된 구역에 설치하도록 되어있습니다. 특수도구, 잠금 장치 및 키, 또는 기타 보안 수단을 통해서만 접근 제한 구역에 들어갈 수 있습니다.

Waarschuwing

Dit apparaat is bedoeld voor installatie in gebieden met een beperkte toegang. Toegang tot dergelijke gebieden kunnen alleen verkregen worden door gebruik te maken van speciaal gereedschap, slot en sleutel of andere veiligheidsmaatregelen.

Battery Handling



Warning! There is the danger of explosion if the battery is replaced incorrectly. Replace the battery only with the same or equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions

電池の取り扱い

電池交換が正しく行われなかった場合、破裂の危険性があります。交換する電池はメーカーが推 奨する型、または同等のものを使用下さい。使用済電池は製造元の指示に従って処分して下さ い。

警告

电池更换不当会有爆炸危险。请只使用同类电池或制造商推荐的功能相当的电池更换原有电 池。请按制造商的说明处理废旧电池。

警告

電池更換不當會有爆炸危險。請使用製造商建議之相同或功能相當的電池更換原有電池。請按 照製造商的說明指示處理廢棄舊電池。

Warnung

Bei Einsetzen einer falschen Batterie besteht Explosionsgefahr. Ersetzen Sie die Batterie nur durch den gleichen oder vom Hersteller empfohlenen Batterietyp. Entsorgen Sie die benutzten Batterien nach den Anweisungen des Herstellers.

Attention

Danger d'explosion si la pile n'est pas remplacée correctement. Ne la remplacer que par une pile de type semblable ou équivalent, recommandée par le fabricant. Jeter les piles usagées conformément aux instructions du fabricant.

¡Advertencia!

Existe peligro de explosión si la batería se reemplaza de manera incorrecta. Reemplazar la batería exclusivamente con el mismo tipo o el equivalente recomendado por el fabricante. Desechar las baterías gastadas según las instrucciones del fabricante.

אזהרה!

קיימת סכנת פיצוץ של הסוללה במידה והוחלפה בדרך לא תקינה. יש להחליף את הסוללה בסוג התואם מחברת יצרן מומלצת. סילוק הסוללות המשומשות יש לבצע לפי הוראות היצרן. هناك خطر من انفجار في حالة اسحبذال البطارية بطريقة غير صحيحة فعليل اسحبذال البطارية فعليا البطارية فعليا فقط بنفس النبع أو ما يعادلها مما أوصث به الشرمة المصنعة حخلص من البطاريات المسحعملة وفقا لحعليمات الشرمة الصانعة

경고!

배터리가 올바르게 교체되지 않으면 폭발의 위험이 있습니다. 기존 배터리와 동일하거나 제조사에서 권장하는 동등한 종류의 배터리로만 교체해야 합니다. 제조사의 안내에 따라 사용된 배터리를 처리하여 주십시오.

Waarschuwing

Er is ontploffingsgevaar indien de batterij verkeerd vervangen wordt. Vervang de batterij slechts met hetzelfde of een equivalent type die door de fabrikant aanbevolen wordt. Gebruikte batterijen dienen overeenkomstig fabrieksvoorschriften afgevoerd te worden.

Redundant Power Supplies



Warning! This unit might have more than one power supply connection. All connections must be removed to de-energize the unit.

冗長電源装置

このユニットは複数の電源装置が接続されている場合があります。

ユニットの電源を切るためには、すべての接続を取り外さなければなりません。

警告

此部件连接的电源可能不止一个,必须将所有电源断开才能停止给该部件供电。

警告

此裝置連接的電源可能不只一個,必須切斷所有電源才能停止對該裝置的供電。

Warnung

Dieses Gerät kann mehr als eine Stromzufuhr haben. Um sicherzustellen, dass der Einheit kein trom zugeführt wird, müssen alle Verbindungen entfernt werden.

¡Advertencia!

Puede que esta unidad tenga más de una conexión para fuentes de alimentación. Para cortar por completo el suministro de energía, deben desconectarse todas las conexiones.

Attention

Cette unité peut avoir plus d'une connexion d'alimentation. Pour supprimer toute tension et tout courant électrique de l'unité, toutes les connexions d'alimentation doivent être débranchées.

אם קיים יותר מספק אחד

אזהרה!

ליחדה יש יותר מחיבור אחד של ספק. יש להסיר את כל החיבורים על מנת לרוקן את היחידה.

> قد يكون لهذا الجهاز عدة اتصالات بوحدات امداد الطاقة . بجب إزالة كافة الاتصالات لعسل الوحدة عن الكهرباء

경고!

이 장치에는 한 개 이상의 전원 공급 단자가 연결되어 있을 수 있습니다. 이 장치에 전원을 차단하기 위해서는 모든 연결 단자를 제거해야만 합니다.

Waarschuwing

Deze eenheid kan meer dan één stroomtoevoeraansluiting bevatten. Alle aansluitingen dienen verwijderd te worden om het apparaat stroomloos te maken.

Backplane Voltage



Warning! Hazardous voltage or energy is present on the backplane when the system is operating. Use caution when servicing.

バックプレーンの電圧

システムの稼働中は危険な電圧または電力が、バックプレーン上にかかっています。

修理する際には注意ください。

警告

当系统正在进行时, 背板上有很危险的电压或能量, 进行维修时务必小心。

警告

當系統正在進行時,背板上有危險的電壓或能量,進行維修時務必小心。

Warnung

Wenn das System in Betrieb ist, treten auf der Rückwandplatine gefährliche Spannungen oder Energien auf. Vorsicht bei der Wartung.

¡Advertencia!

Cuando el sistema está en funcionamiento, el voltaje del plano trasero es peligroso. Tenga cuidado cuando lo revise.

Attention

Lorsque le système est en fonctionnement, des tensions électriques circulent sur le fond de panier. Prendre des précautions lors de la maintenance.

מתח בפנל האחורי

אזהרה!

קיימת סכנת מתח בפנל האחורי בזמן תפעול המערכת. יש להיזהר במהלך

העבודה.

هناك خطز مه التيار الكهزبائي أوالطاقة المبجدة على اللبحة عندما يكنن النظام يعمل كه حذرا عند خدمة هذا الجهاس

경고!

시스템이 동작 중일 때 후면판 (Backplane)에는 위험한 전압이나 에너지가 발생 합니다. 서비스 작업 시 주의하십시오.

Waarschuwing

Een gevaarlijke spanning of energie is aanwezig op de backplane wanneer het systeem in gebruik is. Voorzichtigheid is geboden tijdens het onderhoud.

Comply with Local and National Electrical Codes



Warning! Installation of the equipment must comply with local and national electrical codes.

地方および国の電気規格に準拠

機器の取り付けはその地方および国の電気規格に準拠する必要があります。

警告

设备安装必须符合本地与本国电气法规。

警告

設備安裝必須符合本地與本國電氣法規。

Warnung

Die Installation der Geräte muss den Sicherheitsstandards entsprechen.

¡Advertencia!

La instalacion del equipo debe cumplir con las normas de electricidad locales y nacionales.

Attention

L'équipement doit être installé conformément aux normes électriques nationales et locales.

תיאום חוקי החשמל הארצי

אזהרה!

התקנת הציוד חייבת להיות תואמת לחוקי החשמל המקומיים והארציים.

تركيب المعدات الكهربائية يجب أن يمتثل للقباويه المحلية والبطبية المتعلقة بالكهرباء

경고!

현 지역 및 국가의 전기 규정에 따라 장비를 설치해야 합니다.

Waarschuwing

Bij installatie van de apparatuur moet worden voldaan aan de lokale en nationale elektriciteitsvoorschriften.

Product Disposal



Warning! Ultimate disposal of this product should be handled according to all national laws and regulations.

製品の廃棄

この製品を廃棄処分する場合、国の関係する全ての法律・条例に従い処理する必要があります。

警告

本产品的废弃处理应根据所有国家的法律和规章进行。

警告

本產品的廢棄處理應根據所有國家的法律和規章進行。

Warnung

Die Entsorgung dieses Produkts sollte gemäß allen Bestimmungen und Gesetzen des Landes erfolgen.

¡Advertencia!

Al deshacerse por completo de este producto debe seguir todas las leyes y reglamentos nacionales.

Attention

La mise au rebut ou le recyclage de ce produit sont généralement soumis à des lois et/ou directives de respect de l'environnement. Renseignez-vous auprès de l'organisme compétent.

סילוק המוצר

!אזהרה

סילוק סופי של מוצר זה חייב להיות בהתאם להנחיות וחוקי המדינה.

التخلص النهائي من هذا المنتج ينبغي التعامل معه وفقا لجميع القبانين واللبائح البطنية عند

경고!

이 제품은 해당 국가의 관련 법규 및 규정에 따라 폐기되어야 합니다.

Waarschuwing

De uiteindelijke verwijdering van dit product dient te geschieden in overeenstemming met alle nationale wetten en reglementen.

Fan Warning





Warning! Hazardous moving parts. Keep away from moving fan blades. The fans might still be turning when you remove the fan assembly from the chassis. Keep fingers, screwdrivers, and other objects away from the openings in the fan assembly's housing.

ファンの警告

警告!回転部品に注意。運転中は回転部(羽根)に触れないでください。シャーシから冷却ファン装置を取り外した際、ファンがまだ回転している可能性があります。ファンの開口部に、指、ドライバー、およびその他のものを近づけないで下さい。

警告!

警告!危险的可移动性零件。请务必与转动的风扇叶片保持距离。 当您从机架移除风扇装置、风扇可能仍在转动。小心不要将手指、螺丝起子和其他物品太靠近风扇

警告

危險的可移動性零件。請務必與轉動的風扇葉片保持距離。 當您從機架移除風扇裝置,風扇可能仍在轉動。小心不要將手指、螺絲起子和其他物品太靠近風扇。

Warnung

Gefährlich Bewegende Teile. Von den bewegenden Lüfterblätter fern halten. Die Lüfter drehen sich u. U. noch, wenn die Lüfterbaugruppe aus dem Chassis genommen wird. Halten Sie Finger, Schraubendreher und andere Gegenstände von den Öffnungen des Lüftergehäuses entfernt.

¡Advertencia!

Riesgo de piezas móviles. Mantener alejado de las aspas del ventilador. Los ventiladores podran dar vuelta cuando usted quite ell montaje del ventilador del chasis. Mandtenga los dedos, los destornilladores y todos los objetos lejos de las aberturas del ventilador

Attention

Pieces mobiles dangereuses. Se tenir a l'ecart des lames du ventilateur II est possible que les ventilateurs soient toujours en rotation lorsque vous retirerez le bloc ventilateur du châssis. Prenez garde à ce que doigts, tournevis et autres objets soient éloignés du logement du bloc ventilateur.

!אזהרה

חלקים נעים מסוכנים. התרחק מלהבי המאוורר בפעולהכאשר מסירים את חלקי המאוורר מהמארז, יתכן והמאווררים עדיין עובדים. יש להרחיק למרחק בטוח את האצבעות וכלי עבודה שונים מהפתחים בתוך המאוורר

تحذير! أجزاء متحركة خطرة. ابتعد عن شفرات المروحة المتحركة.من الممكن أن المراوح لا تزال تدورعند إزالة كتلة المروحة من الهيكل يجب إبقاء الأصابع .ومفكات البراغي وغيرها من الأشياء بعيدا عن الفتحات في كتلة المروحة

경고!

움직이는 위험한 부품. 회전하는 송풍 날개에 접근하지 마세요. 섀시로부터 팬 조립품을 제거할 때 팬은 여전히 회전하고 있을 수 있습니다. 팬 조림품 외관의 열려있는 부분들로부터 손가락 및 스크류드라이버, 다른 물체들이 가까이 하지 않도록 배치해 주십시오.

Waarschuwing

Gevaarlijk bewegende onderdelen. Houd voldoende afstand tot de bewegende ventilatorbladen. Het is mogelijk dat de ventilator nog draait tijdens het verwijderen van het ventilatorsamenstel uit het chassis. Houd uw vingers, schroevendraaiers en eventuele andere voorwerpen uit de buurt van de openingen in de ventilatorbehuizing.

Power Cable and AC Adapter



Warning! When installing the product, use the provided or designated connection cables, power cables and AC adaptors. Using any other cables and adaptors could cause a malfunction or a fire. Electrical Appliance and Material Safety Law prohibits the use of UL or CSA -certified cables (that have UL/CSA shown on the cord) for any other electrical devices than products designated by Supermicro only.

電源コードとACアダプター

製品を設置する場合、提供または指定および購入された接続ケーブル、電源コードとACアダプターを該当する地域の条例や安全基準に適合するコードサイズやプラグと共に使用下さい。他のケーブルやアダプタを使用すると故障や火災の原因になることがあります。

電気用品安全法は、ULまたはCSA認定のケーブル(UL/CSAマークがコードに表記)を Supermicro が指定する製品以外に使用することを禁止しています。

警告

安装此产品时,请使用本身提供的或指定的或采购的连接线,电源线和电源适配器,包含遵照当地法规和安全要求的合规的电源线尺寸和插头.使用其它线材或适配器可能会引起故障或火灾。除了Supermicro所指定的产品,电气用品和材料安全法律规定禁止使用未经UL或CSA认证的线材。(线材上会显示UL/CSA符号)。

警告

安裝此產品時,請使用本身提供的或指定的或採購的連接線,電源線和電源適配器‧包含遵照當地法規和安全要求的合規的電源線尺寸和插頭.使用其它線材或適配器可能會引起故障或火災。除了Supermicro所指定的產品,電氣用品和材料安全法律規定禁止使用未經UL或CSA認證的線材。(線材上會顯示UL/CSA符號)。

Warnung

Nutzen Sie beim Installieren des Produkts ausschließlich die von uns zur Verfügung gestellten Verbindungskabeln, Stromkabeln und/oder Adapater, die Ihre örtlichen Sicherheitsstandards einhalten. Der Gebrauch von anderen Kabeln und Adapter können Fehlfunktionen oder Feuer verursachen. Die Richtlinien untersagen das Nutzen von UL oder CAS zertifizierten Kabeln (mit UL/CSA gekennzeichnet), an Geräten oder Produkten die nicht mit Supermicro gekennzeichnet sind.

¡Advertencia!

Cuando instale el producto, utilice la conexión provista o designada o procure cables, Cables de alimentación y adaptadores de CA que cumplan con los códigos locales y los requisitos de seguridad, incluyendo el tamaño adecuado del cable y el enchufe. El uso de otros cables y adaptadores podría causar un mal funcionamiento o un incendio. La Ley de Seguridad de Aparatos Eléctricos y de Materiales prohíbe El uso de cables certificados por UL o CSA (que tienen el certificado UL / CSA en el código) para cualquier otros dispositivos eléctricos que los productos designados únicamente por Supermicro.

Attention

Lors de l'installation du produit, utilisez les cables de connection fournis ou désigné ou achetez des cables, cables de puissance et adaptateurs respectant les normes locales et les conditions de securite y compris les tailles de cables et les prises electriques appropries. L'utilisation d'autres cables et adaptateurs peut provoquer un dysfonctionnement ou un incendie. Appareils électroménagers et la Loi sur la Sécurité Matériel interdit l'utilisation de câbles certifies- UL ou CSA (qui ont UL ou CSA indiqué sur le code) pour tous les autres appareils électriques sauf les produits désignés par Supermicro seulement.

א ימאתמו חיילמשח חילבכ AC

הרהזא!

ךרוצל ומאתוה וא ושכרנ רשא AC םימאתמו םיקפס ,םילבכב שמתשהל שי ,רצומה תא םיניקתמ רשאכ לכב שומיש . עקתהו לבכה לש הנוכנ הדימ ללוכ ,תוימוקמה תוחיטבה תושירדל ומאתוה רשאו ,הנקתהה למשחה ירישכמב שומישה יקוחל םאתהב .ילמשח רצק וא הלקתל םורגל לולע ,רחא גוסמ םאתמ וא לבכ לש דוק םהילע עיפומ רשאכ) CSA-ב וא UL -ב םיכמסומה םילבכב שמתשהל רוסיא םייק ,תוחיטבה יקוחו .דבלב Supermicro י"ע םאתוה רשא רצומב קר אלא ,רחא ילמשח רצומ לכ רובע UL/CSA)

تالباكلا ءارشب مق وأ قددحملا وأ قرفوت مل تالي صوت المادخت ساب مق ، جتن مل بي كرت دن ع كلذ يف امب قيل حمل قمال سال تابلطتمو نين اوقب مازت اللا عم ددرت مل رايت اتال وحمو قيئ البر مكلا قي رح وأ لطع يف ببست دق عرخ اتال وحمو تالباك يأ مادخت الله ميلسل الله الله والله والله

전원 케이블 및 AC 어댑터

경고! 제품을 설치할 때 현지 코드 및 적절한 굵기의 코드와 플러그를 포함한 안전 요구 사항을 준수하여 제공되거나 지정된 연결 혹은 구매 케이블, 전원 케이블 및 AC 어댑터를 사용하십시오.

다른 케이블이나 어댑터를 사용하면 오작동이나 화재가 발생할 수 있습니다. 전기 용품 안전법은 UL 또는 CSA 인증 케이블 (코드에 UL / CSA가 표시된 케이블)을 Supermicro 가 지정한 제품 이외의 전기 장치에 사용하는 것을 금지합니다.

Stroomkabel en AC-Adapter

Waarschuwing! Bij het aansluiten van het Product uitsluitend gebruik maken van de geleverde Kabels of een andere geschikte aan te schaffen Aansluitmethode, deze moet altijd voldoen aan de lokale voorschriften en veiligheidsnormen, inclusief de juiste kabeldikte en stekker. Het gebruik van niet geschikte Kabels en/of Adapters kan een storing of brand veroorzaken. Wetgeving voor Elektrische apparatuur en Materiaalveiligheid verbied het gebruik van UL of CSA -gecertificeerde Kabels (met UL/CSA in de code) voor elke andere toepassing dan de door Supermicro hiervoor beoogde Producten.

Appendix B

System Specifications

Processors

Dual 4th or 5th Generation Intel Xeon Scalable processors with 4 UPI (16 GT/s max) and a total of 160 Gen5 PCIe lanes in a Socket E (LGA-4677), supports 145 W-270 W TDP

Chipset

Intel C741

BIOS

AMI 32 MB SPI Flash EEPROM

Memory

32 DIMM slots, 1 DPC ECC DDR5 RDIMM/LRDIMM for up to 5600 MT/s

Storage Drives

Eight hot-swap E3.S (T1; 7.5 mm) NVMe drive bays

Four E3.S (T2; 15 mm)) CXL drive bays

Two PCIe 3.0 (NVMe or SATA3 Hybrid slots) with support of M-Key 2280 and 22110

PCI Expansion Slots

Two Gen-Z PCIe 5.0 x16 slots (FHHL)

Two Gen-Z x16 AIOM PCIe 5.0 connectors (OCP 3.0 SFF compliant)

Input/Output

Four USB 3.0 ports (two front, two rear)

One rear RJ45 dedicated 1 GbE IPMI

One rear VGA port

One rear UID port

Motherboard

X13DSF-A; 17" (L) x 14" (W) (43 cm x 35 cm)

Chassis

CSE-126E32-R1K62P; 1U; (WxHxD) 17.2 x 1.7 x 30.4 in. (438 x 44 x 773 mm)

System Cooling

Eight heavy duty 4 cm fans with optimal fan speed control

One air shroud

Power Supply

Model: PWS-1K62A-1R, two 2000 W redundant modules, 80 Plus Titanium Level

AC Input

1000 W: 100-127 Vac /50-60 Hz 1600 W: 200-240 Vac / 50-60 Hz

+12 V

Max: 83 A / Min 0A (100 Vac-127 Vac)
Max: 133 A / Min: 0A (200 Vac-240 Vac)

+12 V SB

Max: 2.1A / Min: 0A

Operating Environment

Operating Temperature: 10° to 35° C (50° to 95° F)

Non-operating Temperature: -40° to 60° C (-40° to 140° F)

Operating Relative Humidity: 8% to 90% (non-condensing)

Non-operating Relative Humidity: 8% to 95% (non-condensing)

Regulatory Compliance

FCC, ICES, CE, UKCA, VCCI, RCM, NRTL, CB

Applied Directives, Standards

EMC/EMI: 2014/30/EU (EMC Directive) CLASS A Electromagnetic Compatibility Regulations 2016

FCC Part 15

ICES-003

VCCI-CISPR 32

AS/NZS CISPR 32

BS/EN 55032

BS/EN 55035

CISPR 32

CISPR 35

BS/EN 61000-3-2

BS/EN 61000-3-3

BS/EN 61000-4-2

BS/EN 61000-4-3

BS/EN 61000-4-4

BS/EN 61000-4-5

BS/EN 61000-4-6

BS/EN 61000-4-8

BS/EN 61000-4-11

Product Safety: 2014/35/EU (LVD Directive) UL/CSA 62368-1 (USA and Canada)

Electrical Equipment (Safety) Regulations 2016

IEC/BS/EN 62368-1

Environment:

2011/65/EU (RoHS Directive)

EC 1907/2006 (REACH)

2012/19/EU (WEEE Directive)

Warning! This product can expose you to chemicals including lead, known to the State of California to cause cancer and birth defects or other reproductive harm. For more information, go to www.P65Warnings.ca.gov.

Perchlorate Warning

California Best Management Practices Regulations for Perchlorate Materials: This Perchlorate warning applies only to products containing CR (Manganese Dioxide) Lithium coin cells. Perchlorate Material-special handling may apply. See www. dtsc. ca. gov/ hazardouswaste/perchlorate

この装置は、クラスA機器です。この装置を住宅環境で使用すると電波妨害を引き起こすことがあります。この場合には使用者が適切な対策を講ずるよう要求されることがあります。 VCCI - A

General Data Center Environmental Specifications

Particulate contamination specifications

Air filtration: Data centers must be kept clean to Class 8 of ISO 14644-1 (ISO 2015). The air entering the data center should be filtered with a MERV 11 filter or better. The air within the data center should be continuously filtered with a MERV 8 filter or better.

Conductive dust: Air should be free fo conductive dust, zinc whiskers, or other conductive particles.

Corrrosive dust: Air should be free of corrosive dust.

Gaseous* contamination specifications

Copper coupon corrosion rate: <300 Å/month per class G1 as defined by ANSI.ISA71.04-2013, reference by ASHRAE TC 9.9

Silver coupon corrosion rate: <200 Å/month per class G1 as defined by ANSI.ISA71.04-2013, reference by ASHRAE TC 9.9 *If testing with silver or copper coupons results in values less that 200 Å/month or 300 Å/month, respectively, then operating up to 70% relative humidity (RH) is acceptable. If the testing shows corrosion levels exceed these limits, then catalyst-type pollutants are probably present and RH should be driven to 50% or lower.